Micro PMU with 1.2 A Buck Regulator and Two 300 mA LDOs

Data Sheet

ADP5040

FEATURES

- **Input voltage range: 2.3 V to 5.5 V**
- **One 1.2 A buck regulator**
- **Two 300 mA LDOs**
- **20-lead, 4 mm × 4 mm LFCSP package**
- **Overcurrent and thermal protection**
- **Soft start**
- **Undervoltage lockout**
- **Buck key specifications**
  - **Output voltage range: 0.8 V to 3.8 V**
  - **Current mode topology for excellent transient response**
  - **3 MHz operating frequency**
  - **Peak efficiency up to 96%**
  - **Uses tiny multilayer inductors and capacitors**
  - **Mode pin selects forced PWM or auto PWM/PSM modes**
  - **100% duty cycle low dropout mode**
- **LDOs key specifications**
  - **Output voltage range: 0.8 V to 5.2 V**
  - **Low V_{IN} from 1.7 V to 5.5 V**
  - **Stable with 2.2 µF ceramic output capacitors**
  - **High PSRR**
  - **Low output noise**
  - **Low dropout voltage**
  - **−40°C to +125°C junction temperature range**

GENERAL DESCRIPTION

The ADP5040 combines one high performance buck regulator and two low dropout regulators (LDO) in a small 20-lead LFCSP to meet demanding performance and board space requirements.

The high switching frequency of the buck regulator enables the use of tiny multilayer external components and minimizes board space.

When the MODE pin is set to logic high, the buck regulator operates in forced pulse width modulation (PWM) mode. When the MODE pin is set to logic low, the buck regulator operates in PWM mode when the load is around the nominal value. When the load current falls below a predefined threshold the regulator operates in power save mode (PSM) improving the light-load efficiency. The low quiescent current, low dropout voltage, and wide input voltage range of the ADP5040 LDOs extend the battery life of portable devices. The ADP5040 LDOs maintain a power supply rejection greater than 60 dB for frequencies as high as 10 kHz while operating with a low headroom voltage.

Each regulator in the ADP5040 is activated by a high level on the respective enable pin. The output voltages of the regulators are programmed though external resistor dividers to address a variety of applications.

FUNCTIONAL BLOCK DIAGRAM

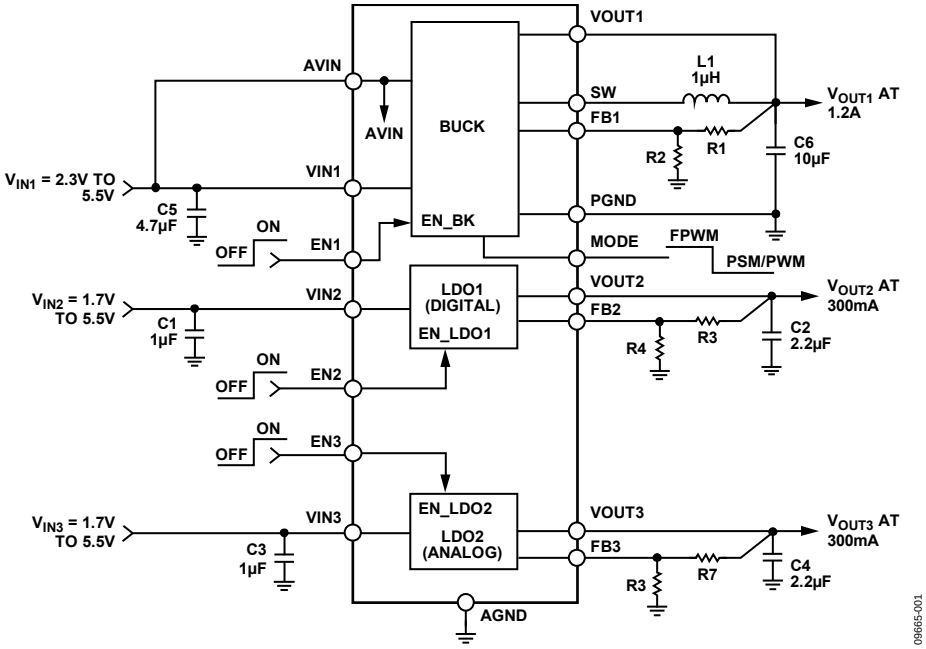


Figure 1.

Rev. D **Document Feedback**

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One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781.329.4700

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REVISION HISTORY

5/2019—Rev. C to Rev. D

Changes to Figure 106 ... 30

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Changes to Ordering Guide ... 37

3/2017—Rev. A to Rev. B

Changes to Figure 2 and Table 7 ... 8

1/2014—Rev. 0 to Rev. A

Change to Figure 1 ... 1
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12/2011—Revision 0: Initial Version

SPECIFICATIONS

GENERAL SPECIFICATIONS

AVIN, VIN1 = 2.3 V to 5.5 V; AVIN, VIN1 ≥VIN2, VIN3; VIN2, VIN3 = 1.7 V to 5.5 V, T_J = −40°C to +125°C for minimum/maximum specifications, and T_A = 25°C for typical specifications, unless otherwise noted.

Table 1.

Parameter	Symbol	Description	Min	Typ	Max	Unit
AVIN UNDERVOLTAGE LOCKOUT	$UVLO_{AVIN}$					
Input Voltage Rising	$UVLO_{AVINRISE}$					
Option 0					2.275	V
Option 1					3.9	V
Input Voltage Falling	$UVLO_{AVINFALL}$					
Option 0			1.95			V
Option 1			3.1			V
SHUTDOWN CURRENT	I_{GND-SD}	ENx = GND		0.1	2	µA
Thermal Shutdown Threshold	TS_{SD}	T_J rising		150		°C
Thermal Shutdown Hysteresis	TS_{SD-HYS}			20		°C
START-UP TIME[1]						
BUCK	t_{START1}			250		µs
LDO1, LDO2	t_{START2}	V_{OUT2}, V_{OUT3} = 3.3 V		85		µs
Enx, MODE, INPUTS						
Input Logic High	V_{IH}	2.5 V ≤ AVIN ≤ 5.5 V	1.2			V
Input Logic Low	V_{IL}	2.5 V ≤ AVIN ≤ 5.5 V			0.4	V
Input Leakage Current	$V_{I-LEAKAGE}$	ENx = AVIN or GND		0.05	1	µA

[1] Start-up time is defined as the time from the moment EN1 = EN2 = EN3 transfers from 0 V to V_{AVIN} to the moment VOUT1, VOUT2, and VOUT3 reach 90% of their nominal level. Start-up times are shorter for individual channels if another channel is already enabled. See the Typical Performance Characteristics section for more information.

BUCK SPECIFICATIONS

AVIN, VIN1 = 2.3 V to 5.5 V; V_{OUT1} = 1.8 V; L = 1 µH; C_{IN} = 10 µF; C_{OUT} = 10 µF; T_J= −40°C to +125°C for minimum/maximum specifications, and T_A = 25°C for typical specifications, unless otherwise noted.[1]

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Input Voltage Range	V_{IN1}		2.3		5.5	V
OUTPUT CHARACTERISTICS						
Output Voltage Accuracy	V_{OUT1}	PWM mode, I_{LOAD} = 0 mA to 1200 mA	−3		+3	%
Line Regulation	$(\Delta V_{OUT1}/V_{OUT1})/\Delta V_{IN1}$	PWM mode		−0.05		%/V
Load Regulation	$(\Delta V_{OUT1}/V_{OUT1})/\Delta I_{OUT1}$	I_{LOAD} = mA to 1200 mA, PWM mode		−0.1		%/A
VOLTAGE FEEDBACK	V_{FB1}		0.485	0.5	0.515	V
PWM TO POWER SAVE MODE CURRENT THRESHOLD	I_{PSM_L}			100		mA
INPUT CURRENT CHARACTERISTICS		MODE = ground				
DC Operating Current	I_{NOLOAD}	I_{LOAD} = 0 mA, device not switching, all other channels disabled		21	35	µA
Shutdown Current	I_{SHTD}	EN1 = 0 V, $T_A = T_J$ = −40°C to +125°C		0.2	1.0	µA

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
SW CHARACTERISTICS						
SW On Resistance	R_{PFET}	PFET, AVIN = VIN1 = 3.6 V		180	240	mΩ
		PFET, AVIN = VIN1 = 5 V		140	190	mΩ
	R_{NFET}	NFET, AVIN = VIN1 = 3.6 V		170	235	mΩ
		NFET, AVIN = VIN1 = 5 V		150	210	mΩ
Current Limit	I_{LIMIT}	PFET switch peak current limit	1600	1950	2300	mA
ACTIVE PULL-DOWN		EN1 = 0 V		85		Ω
OSCILLATOR FREQUENCY	F_{OSC}		2.5	3.0	3.5	MHz

[1] All limits at temperature extremes are guaranteed via correlation using standard statistical quality control (SQC).

LDO1, LDO2 SPECIFICATIONS

V_{IN2}, V_{IN3} = (V_{OUT2}, V_{OUT3} + 0.5 V) or 1.7 V (whichever is greater) to 5.5 V; AVIN, VIN1 ≥ VIN2, VIN3; C_{IN} = 1 µF, C_{OUT} = 2.2 µF; T_J= −40°C to +125°C for minimum/maximum specifications, and T_A = 25°C for typical specifications, unless otherwise noted. [1]

Table 3.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT VOLTAGE RANGE	V_{IN2}, V_{IN3}	T_J = −40°C to +125°C	1.7		5.5	V
OPERATING SUPPLY CURRENT						
Bias Current per LDO[2]	$I_{VIN2BIAS}$/$I_{VIN3BIAS}$	I_{OUT3} = I_{OUT4} = 0 µA		10	30	µA
		I_{OUT2} = I_{OUT3} = 10 mA		60	100	µA
		I_{OUT2} = I_{OUT3} = 300 mA		165	245	µA
Total System Input Current	I_{IN}	Includes all current into AVIN, VIN1, VIN2 and VIN3				
LDO1 or LDO2 Only		I_{OUT2} = I_{OUT3} = 0 µA, all other channels disabled		53		µA
LDO1 and LDO2 Only		I_{OUT2} = I_{OUT3} = 0 µA, buck disabled		74		µA
OUTPUT VOLTAGE ACCURACY	V_{OUT2}, V_{OUT3}	100 µA < I_{OUT2} < 300 mA, 100 µA < I_{OUT3} < 300 mA V_{IN2} = (V_{OUT2} + 0.5 V) to 5.5 V, V_{IN3} = (V_{OUT3} + 0.5 V) to 5.5 V	−3		+3	%
REFERENCE VOLTAGE	V_{FB2}, V_{FB3}		0.485	0.500	0.515	V
REGULATION						
Line Regulation	(ΔV_{OUT2}/V_{OUT2})/ΔV_{IN2} (ΔV_{OUT3}/V_{OUT3})/ΔV_{IN3}	V_{IN2} = (V_{OUT2} + 0.5 V) to 5.5 V V_{IN3} = (V_{OUT3} + 0.5 V) to 5.5 V I_{OUT2} = I_{OUT3} = 1 mA	−0.03		+0.03	%/V
Load Regulation[3]	(ΔV_{OUT2}/V_{OUT2})/ΔI_{OUT2} (ΔV_{OUT3}/V_{OUT3})/ΔI_{OUT3}	I_{OUT2} = I_{OUT3} = 1 mA to 300 mA		0.002	0.0075	%/mA
DROPOUT VOLTAGE[4]	$V_{DROPOUT}$					
		V_{OUT2} = V_{OUT3} = 5.0 V, I_{OUT2} = I_{OUT3} = 300 mA		72		mV
		V_{OUT2} = V_{OUT3} = 3.3 V, I_{OUT2} = I_{OUT3} = 300 mA		86	140	mV
		V_{OUT2} = V_{OUT3} = 2.5 V, I_{OUT2} = I_{OUT3} = 300 mA		107		mV
		V_{OUT2} = V_{OUT3} = 1.8 V, I_{OUT2} = I_{OUT3} = 300 mA		180		mV
ACTIVE PULL-DOWN	R_{PDLDO}	EN2/EN3 = 0 V		600		Ω
CURRENT-LIMIT THRESHOLD[5]	I_{LIMIT}	T_J = −40°C to +125°C	335	470		mA
OUTPUT NOISE	$OUT_{LDO2NOISE}$	10 Hz to 100 kHz, V_{IN3} = 5 V, V_{OUT3} = 3.3 V		123		µV rms
		10 Hz to 100 kHz, V_{IN3} = 5 V, V_{OUT3} = 2.8 V		110		µV rms
		10 Hz to 100 kHz, V_{IN3} = 5 V, V_{OUT3} = 1.5 V		59		µV rms
	$OUT_{LDO1NOISE}$	10 Hz to 100 kHz, V_{IN2} = 5 V, V_{OUT2} = 3.3 V		140		µV rms
		10 Hz to 100 kHz, V_{IN2} = 5 V, V_{OUT2} = 2.8 V		129		µV rms
		10 Hz to 100 kHz, V_{IN2} = 5 V, V_{OUT2} = 1.5 V		66		µV rms

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
POWER SUPPLY REJECTION RATIO	PSRR	1 kHz, V_{IN2}, V_{IN3} = 3.3 V, V_{OUT2}, V_{OUT3} = 2.8 V, I_{OUT} = 100 mA		66		dB
		100 kHz, V_{IN2}, V_{IN3} = 3.3 V, V_{OUT2}, V_{OUT3} = 2.8 V, I_{OUT} = 100 mA		57		dB
		1 MHz, V_{IN2}, V_{IN3} = 3.3 V, V_{OUT2}, V_{OUT3} = 2.8 V, I_{OUT} = 100 mA		60		dB

[1] All limits at temperature extremes are guaranteed via correlation using standard statistical quality control (SQC).
[2] This is the input current into V_{IN2} and V_{IN3}, which is not delivered to the output load.
[3] Based on an end-point calculation using 1 mA and 300 mA loads.
[4] Dropout voltage is defined as the input-to-output voltage differential when the input voltage is set to the nominal output voltage. This applies only for output voltages above 1.7 V.
[5] Current-limit threshold is defined as the current at which the output voltage drops to 90% of the specified typical value. For example, the current limit for a 3.0 V output voltage is defined as the current that causes the output voltage to drop to 90% of 3.0 V, or 2.7 V.

INPUT AND OUTPUT CAPACITOR, RECOMMENDED SPECIFICATIONS

Table 4.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CAPACITANCE (BUCK)[1]	C_{MIN1}	T_J = −40°C to +125°C	4.7		40	µF
OUTPUT CAPACITANCE (BUCK)[2]	C_{MIN2}	T_J = −40°C to +125°C	7		40	µF
INPUT AND OUTPUT CAPACITANCE[3] (LDO1, LDO2)	C_{MIN34}	T_J = −40°C to +125°C	0.70			µF
CAPACITOR ESR	R_{ESR}	T_J = −40°C to +125°C	0.001		1	Ω

[1] The minimum input capacitance should be greater than 4.7 µF over the full range of operating conditions. The full range of operating conditions in the application must be considered during device selection to ensure that the minimum capacitance specification is met. X7R and X5R type capacitors are recommended, whereas Y5V and Z5U capacitors are not recommended for use with the buck.
[2] The minimum output capacitance should be greater than 7 µF over the full range of operating conditions. The full range of operating conditions in the application must be considered during device selection to ensure that the minimum capacitance specification is met. X7R and X5R type capacitors are recommended, whereas Y5V and Z5U capacitors are not recommended for use with the buck.
[3] The minimum input and output capacitance should be greater than 0.70 µF over the full range of operating conditions. The full range of operating conditions in the application must be considered during device selection to ensure that the minimum capacitance specification is met. X7R and X5R type capacitors are recommended, whereas Y5V and Z5U capacitors are not recommended for use with LDOs.

ABSOLUTE MAXIMUM RATINGS

Table 5.

Parameter	Rating
AVIN to AGND	−0.3 V to +6 V
VIN1 to AVIN	−0.3 V to +0.3 V
PGND to AGND	−0.3 V to +0.3 V
VIN2, VIN3, VOUTx, ENx, MODE, FBx, SW to AGND	−0.3 V to (AVIN + 0.3 V)
SW to PGND	−0.3 V to (VIN1 + 0.3 V)
Storage Temperature Range	−65°C to +150°C
Operating Junction Temperature Range	−40°C to +125°C
Soldering Conditions	JEDEC J-STD-020
ESD Human Body Model	3000 V
ESD Charged Device Model	1500 V
ESD Machine Model	200 V

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 6. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
20-Lead, 0.5 mm pitch LFCSP	38	4.2	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

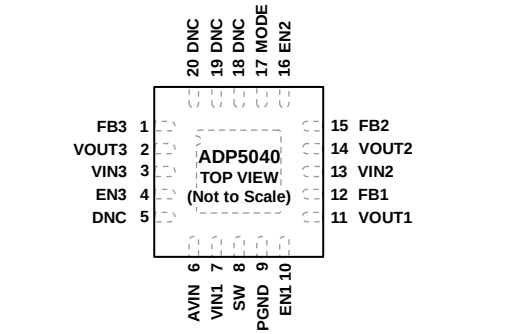


Figure 2. Pin Configuration—View from Top of the Die

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	FB3	LDO2 Feedback Input.
2	VOUT3	LDO2 Output Voltage.
3	VIN3	LDO2 Input Supply (1.7 V to 5.5 V).
4	EN3	Enable LDO2. EN3 = high: turn on LDO2; EN3 = low: turn off LDO2.
6	AVIN	Housekeeping Input Supply (2.3 V to 5.5 V).
7	VIN1	Buck Input Supply (2.3 V to 5.5 V).
8	SW	Buck Switching Node.
9	PGND	Dedicated Power Ground for Buck Regulator.
10	EN1	Enable Buck. EN1 = high: turn on buck; EN1 = low: turn off buck.
11	VOUT1	Buck Output Sensing Node.
12	FB1	Buck Feedback Input.
13	VIN2	LDO1 Input Supply (1.7 V to 5.5 V).
14	VOUT2	LDO1 Output Voltage.
15	FB2	LDO1 Feedback Input.
16	EN2	Enable LDO1. EN2 = high: turn on LDO1; EN2 = low: turn off LDO1.
17	MODE	Buck Mode. Mode = high: buck regulator operates in fixed PWM mode; mode = low: buck regulator operates in power save mode (PSM) at light load and in constant PWM at higher load.
5, 18, 19, 20	DNC	Do Not Connect. Do not connect this pin.
	EPAD	Exposed Pad. (AGND = Analog Ground). The exposed pad must be connected to the system ground plane.

TYPICAL PERFORMANCE CHARACTERISTICS

VIN1 = VIN2 = VIN3 = AVIN = 5.0 V, T_A = 25°C, unless otherwise noted.

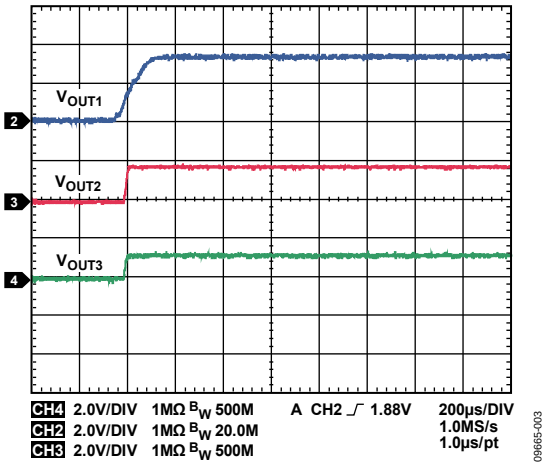


Figure 3. 3-Channel Start-Up Waveforms

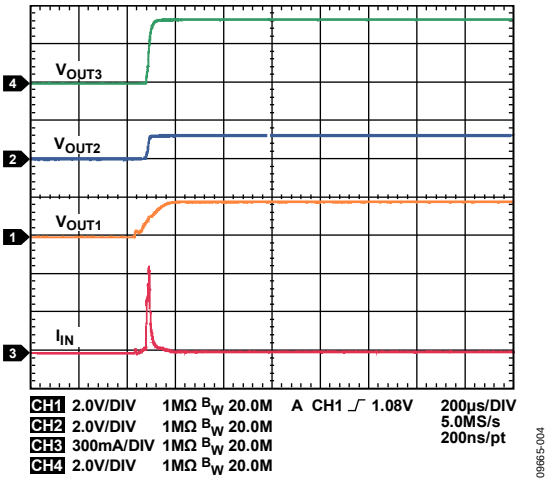


Figure 4. Total Inrush Current, All Channels Started Simultaneously

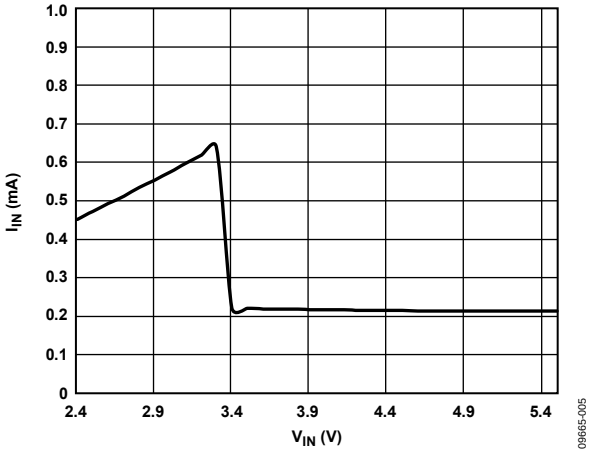


Figure 5. System Quiescent Current (Sum of All the Input Currents) vs. Input Voltage, V_{OUT1} = 1.8 V, V_{OUT2} = V_{OUT3} = 3.3 V (UVLO = 3.3 V)

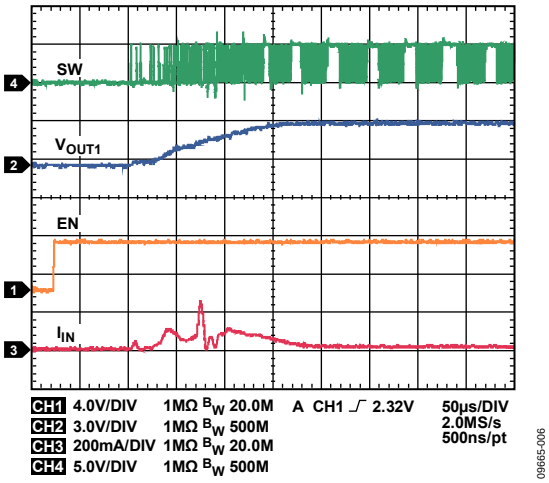


Figure 6. Buck Startup, V_{OUT1} = 3.3 V, I_{OUT2} = 20 mA

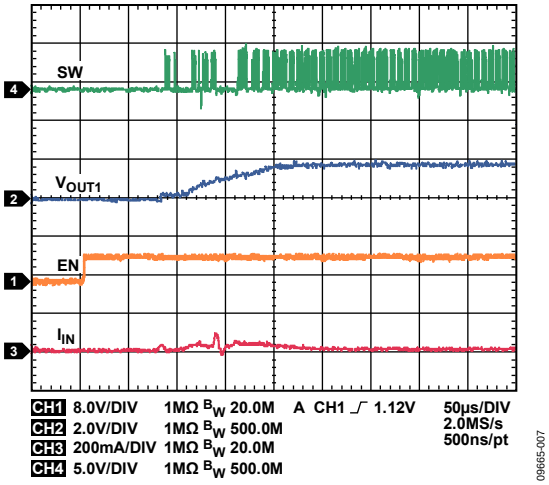


Figure 7. Buck Startup, V_{OUT1} = 1.8 V, I_{OUT} = 20 mA

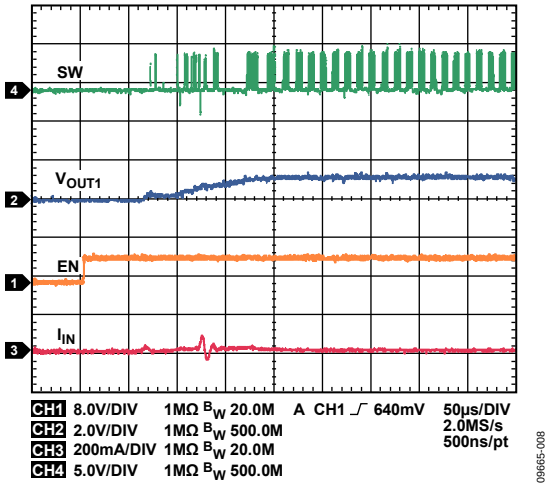


Figure 8. Buck Startup, V_{OUT1} = 1.2 V, I_{OUT} = 20 mA

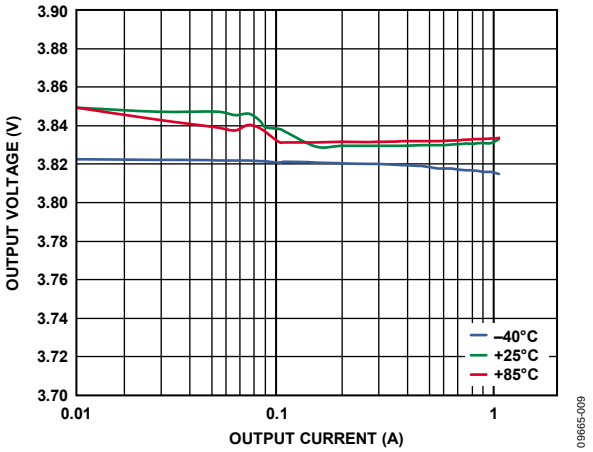


Figure 9. Buck Load Regulation Across Temperature, V_{OUT1} = 3.8 V, Auto Mode

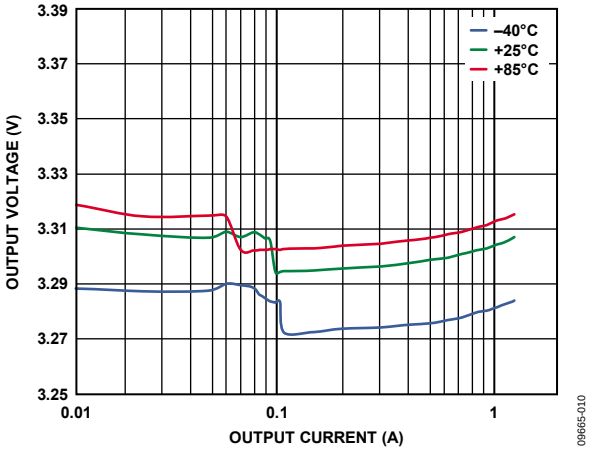


Figure 10. Buck Load Regulation Across Temperature, V_{OUT1} = 3.3 V, Auto Mode

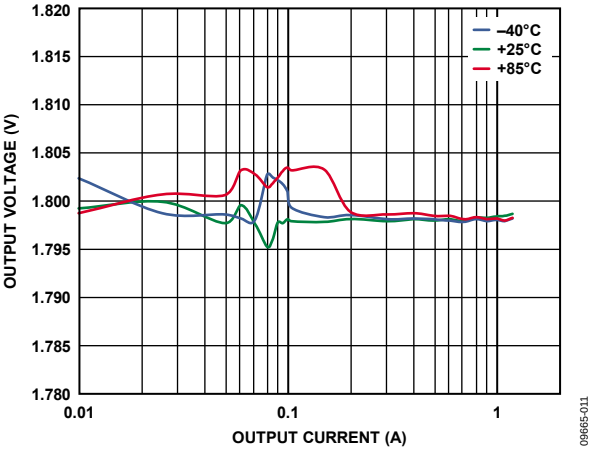


Figure 11. Buck Load Regulation Across Temperature, V_{OUT1} = 1.8 V, Auto Mode

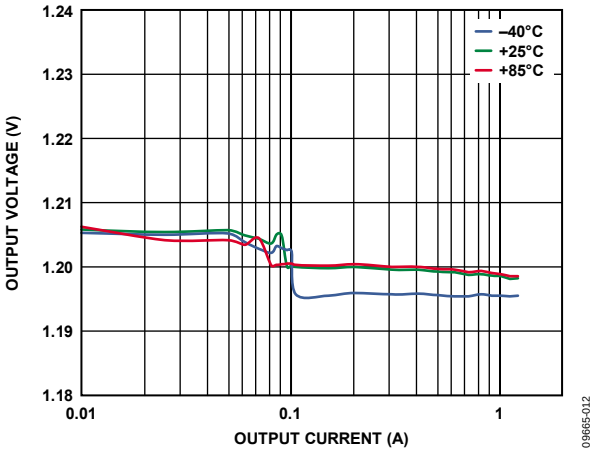


Figure 12. Buck Load Regulation Across Temperature, V_{OUT1} = 1.2 V, Auto Mode

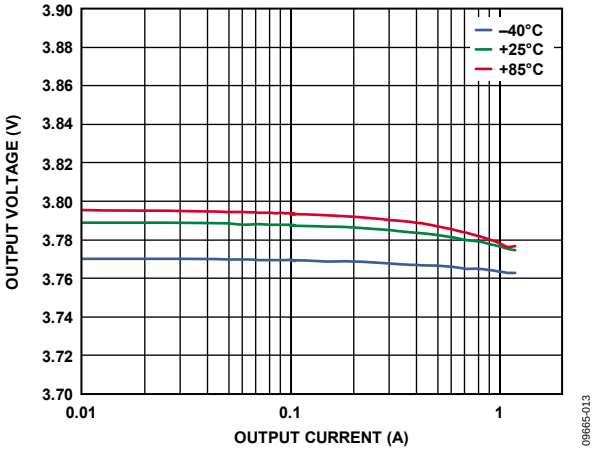


Figure 13. Buck Load Regulation Across Temperature, V_{OUT1} = 3.8 V, PWM Mode

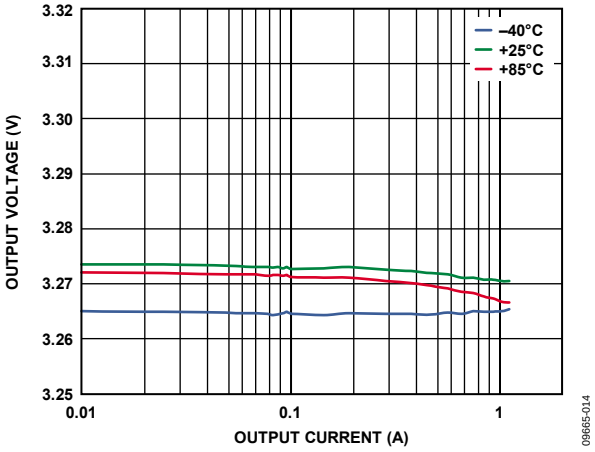


Figure 14. Buck Load Regulation Across Temperature, V_{OUT1} = 3.3 V, PWM Mode

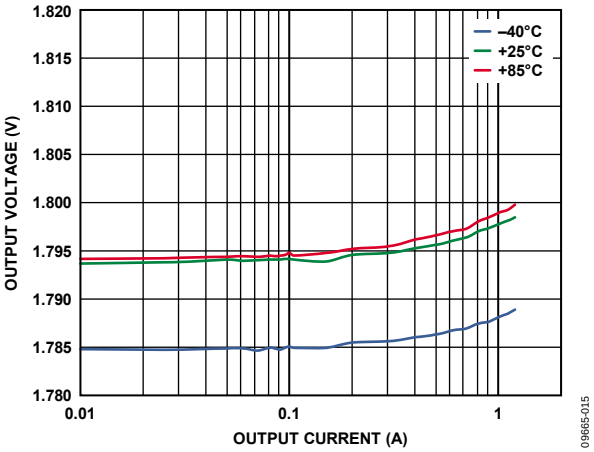


Figure 15. Buck Load Regulation Across Temperature, V_{OUT1} = 1.8 V, PWM Mode

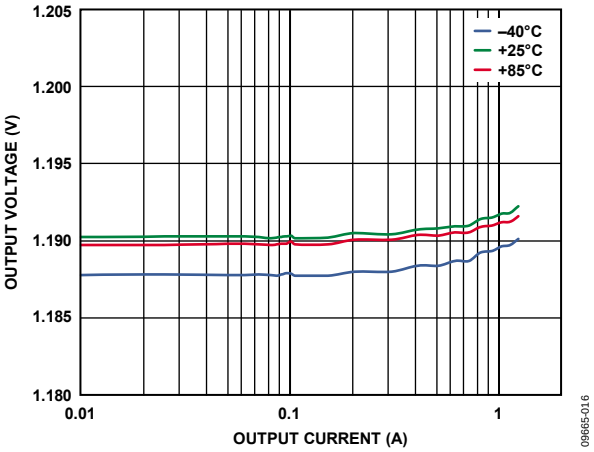


Figure 16. Buck Load Regulation Across Temperature, V_{OUT1} = 1.2 V, PWM Mode

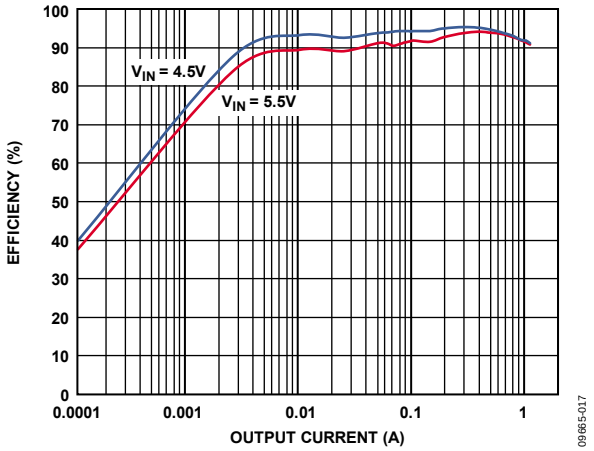


Figure 17. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 3.8 V, Auto Mode

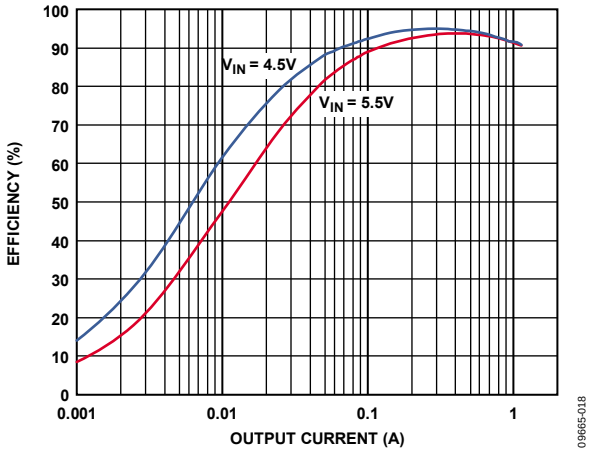


Figure 18. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 3.8 V, PWM Mode

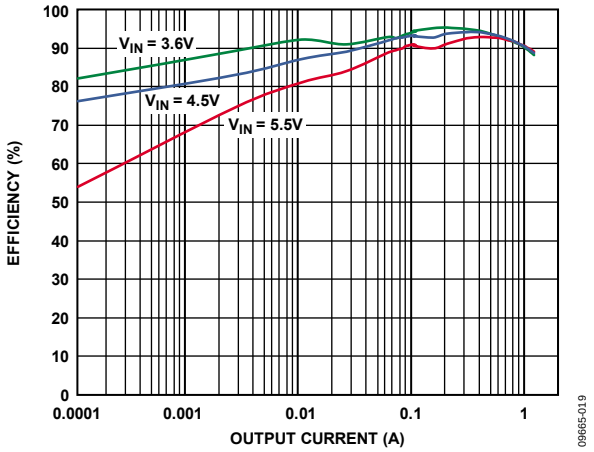


Figure 19. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 3.3 V, Auto Mode

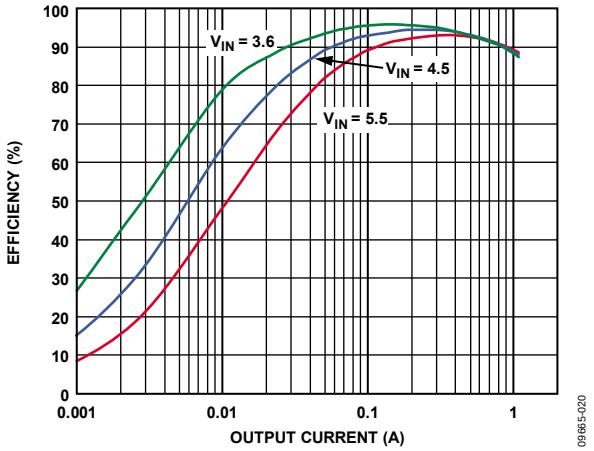


Figure 20. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 3.3 V, PWM Mode

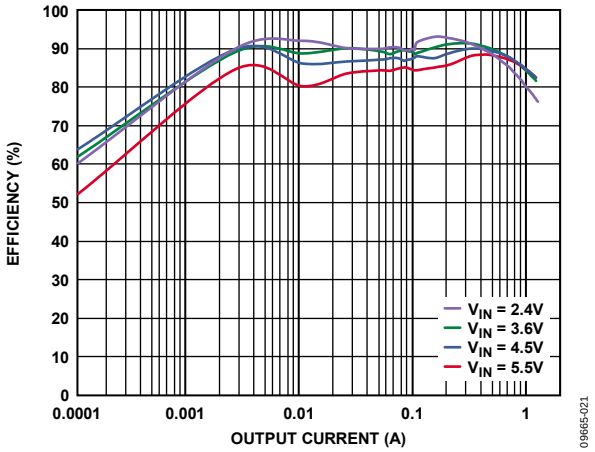


Figure 21. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 1.8 V, Auto Mode

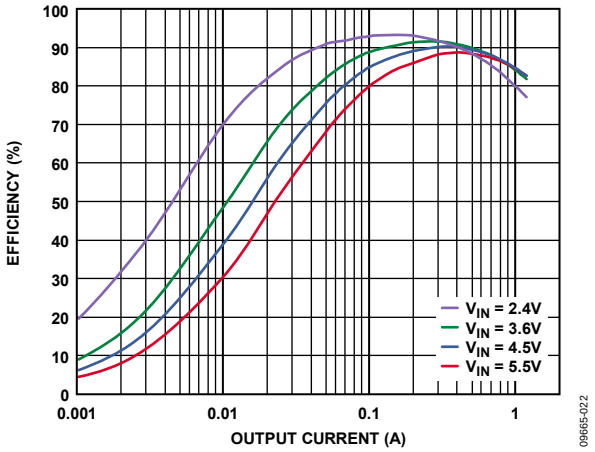


Figure 22. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 1.8 V, PWM Mode

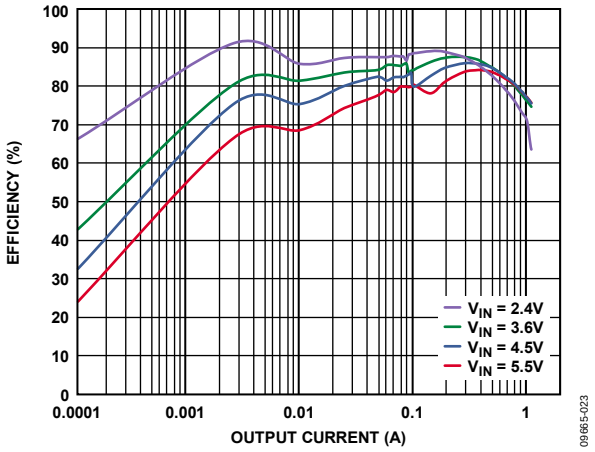


Figure 23. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 1.2 V, Auto Mode

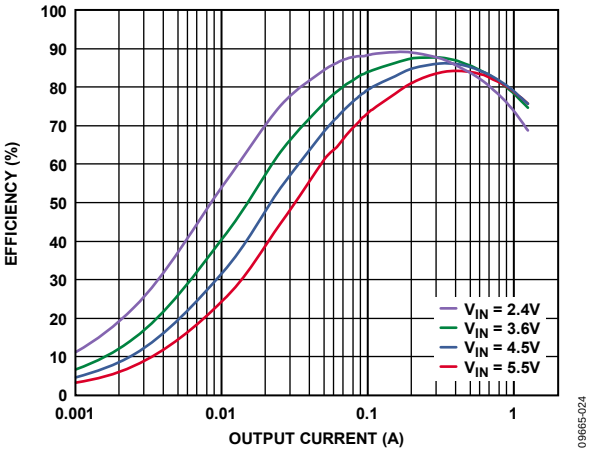


Figure 24. Buck Efficiency vs. Load Current, Across Input Voltage, V_{OUT1} = 1.2 V, PWM Mode

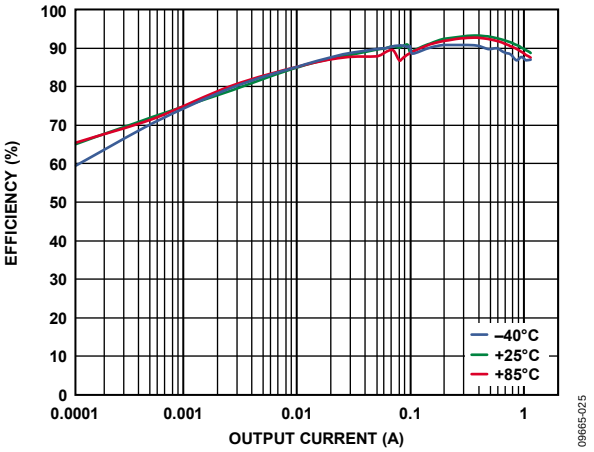


Figure 25. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 3.3 V, Auto Mode

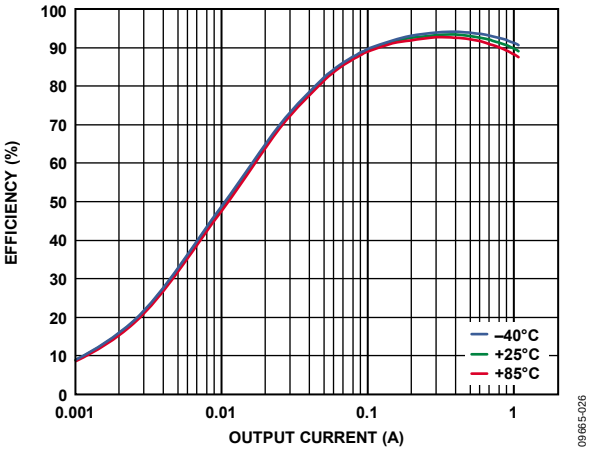


Figure 26. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 3.3 V, PWM Mode

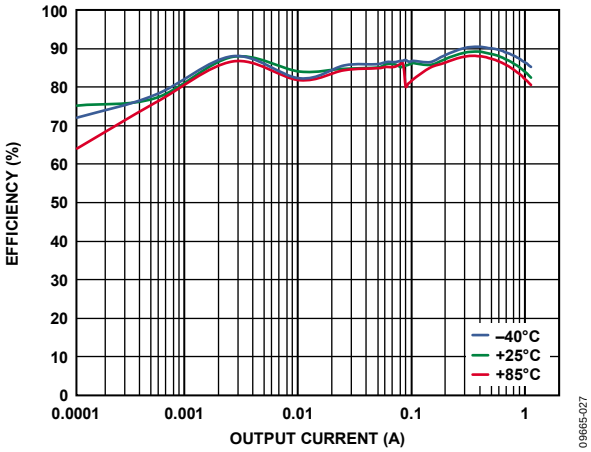


Figure 27. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 1.8 V, Auto Mode

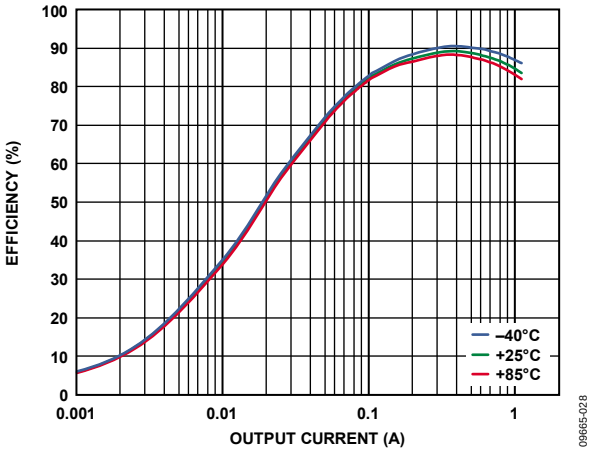


Figure 28. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 1.8 V, PWM Mode

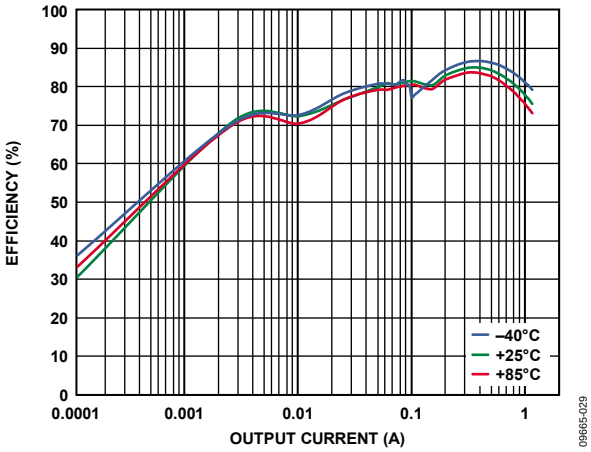


Figure 29. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 1.2 V, Auto Mode

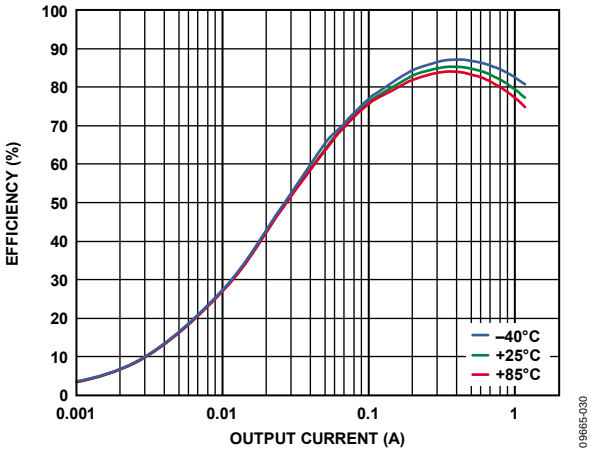


Figure 30. Buck Efficiency vs. Load Current, Across Temperature, V_{IN} = 5.0 V, V_{OUT1} = 1.2 V, PWM Mode

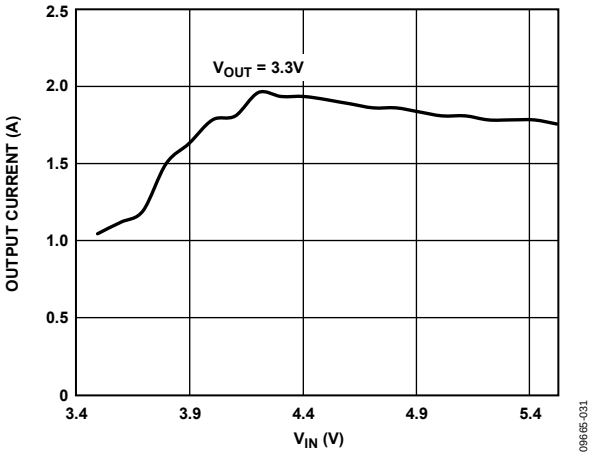


Figure 31. Buck DC Current Capability vs. Input Voltage

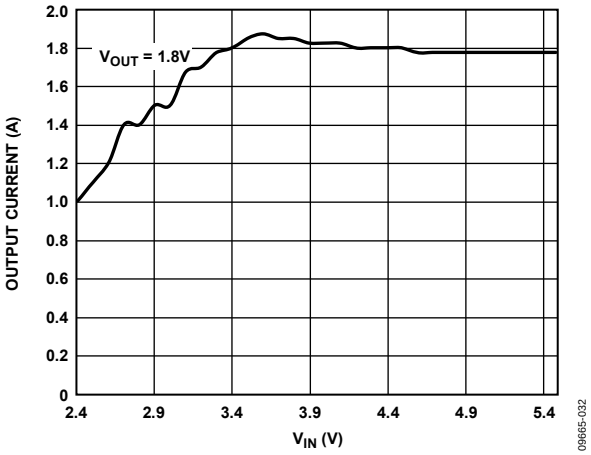


Figure 32. Buck DC Current Capability vs. Input Voltage

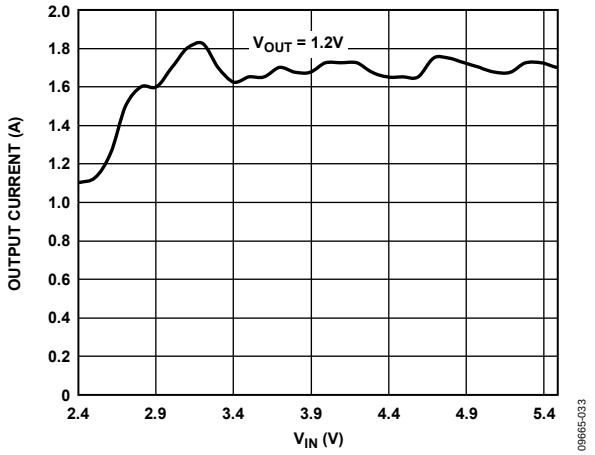


Figure 33. Buck DC Current Capability vs. Input Voltage

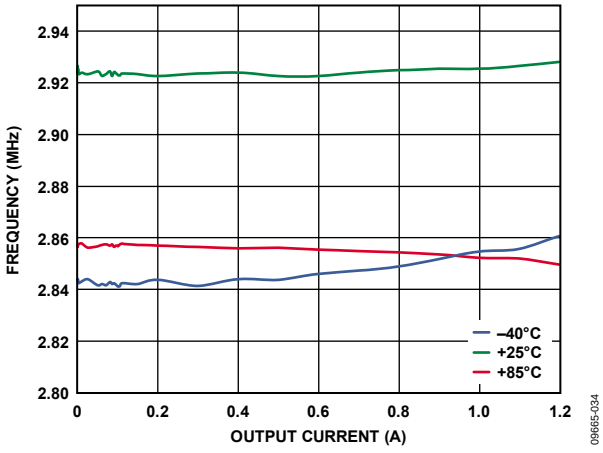


Figure 34. Buck Switching Frequency vs. Output Current, Across Temperature, V_{OUT1} = 1.8 V, PWM Mode

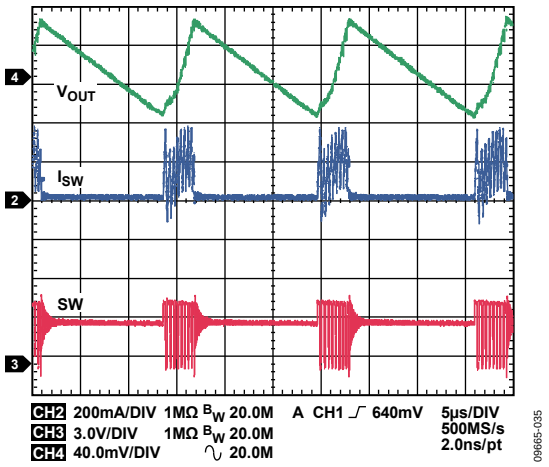


Figure 35. Typical Waveforms, V_{OUT1} = 3.3 V, I_{OUT1} = 30 mA, Auto Mode

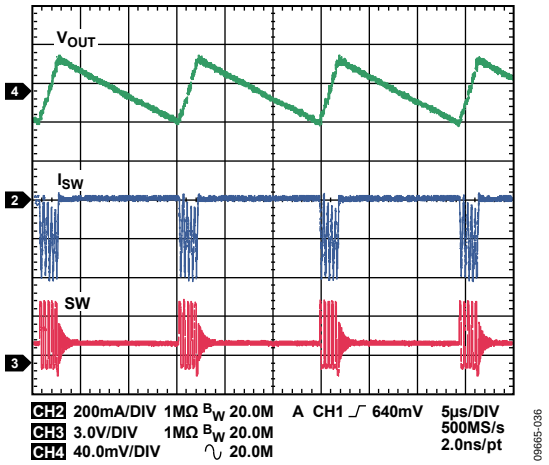


Figure 36. Typical Waveforms, V_{OUT1} = 1.8 V, I_{OUT1} = 30 mA, Auto Mode

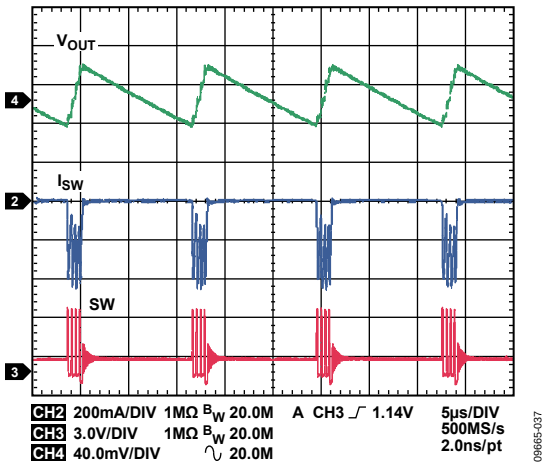


Figure 37. Typical Waveforms, V_{OUT1} = 1.2 V, I_{OUT1} = 30 mA, Auto Mode

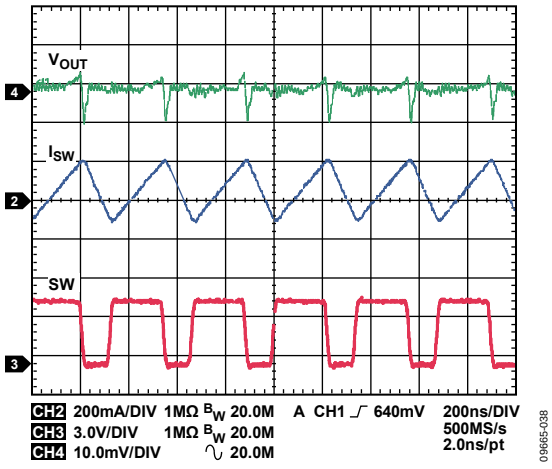


Figure 38. Typical Waveforms, V_{OUT1} = 3.3 V, I_{OUT1} = 30 mA, PWM Mode

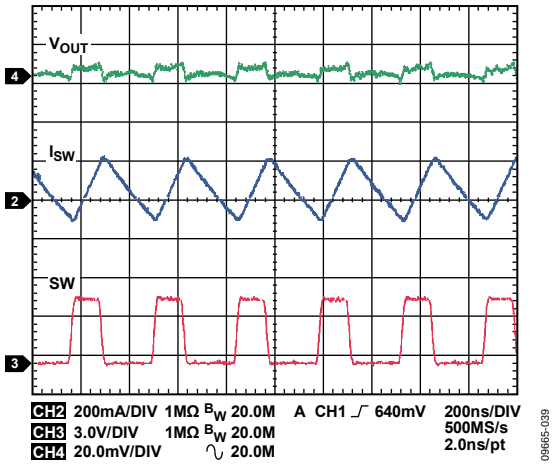


Figure 39. Typical Waveforms, V_{OUT1} = 1.8 V, I_{OUT1} = 30 mA, PWM Mode

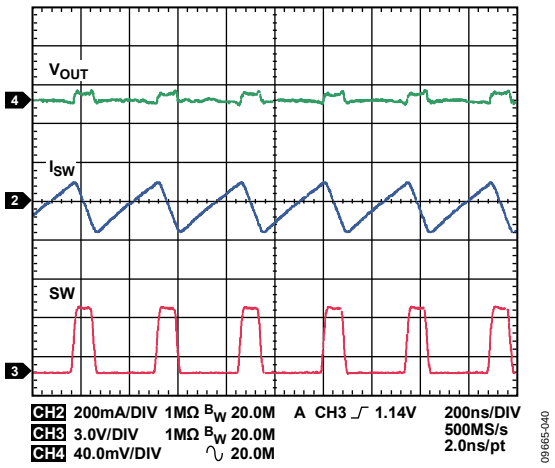


Figure 40. Typical Waveforms, V_{OUT1} = 1.2 V, I_{OUT1} = 30 mA, PWM Mode

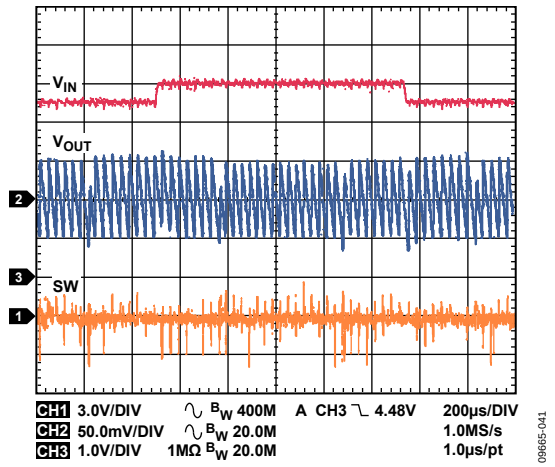


Figure 41. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 3.3 V, I_{OUT1} = 5 mA, Auto Mode

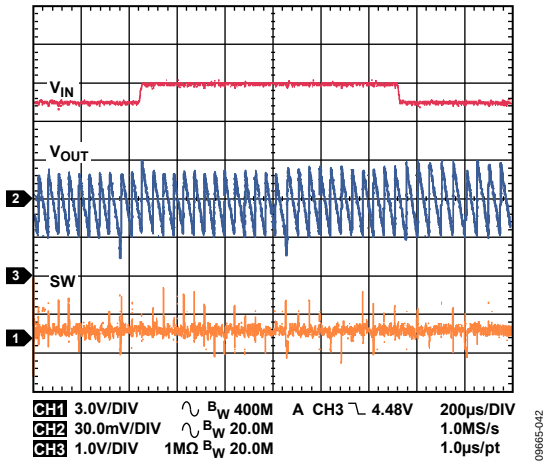


Figure 42. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 1.8 V, I_{OUT1} = 5 mA, Auto Mode

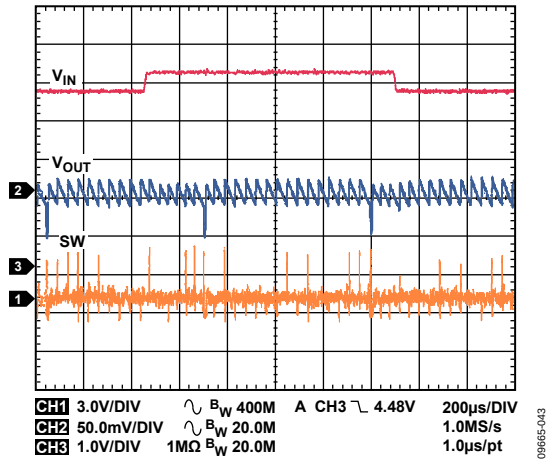


Figure 43. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 1.2 V, I_{OUT1} = 5 mA, Auto Mode

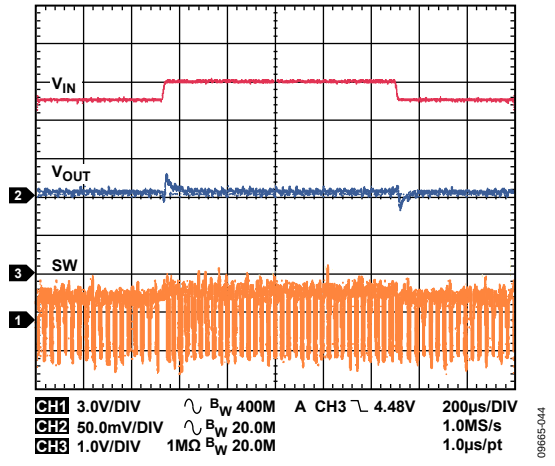


Figure 44. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 3.3 V, PWM Mode

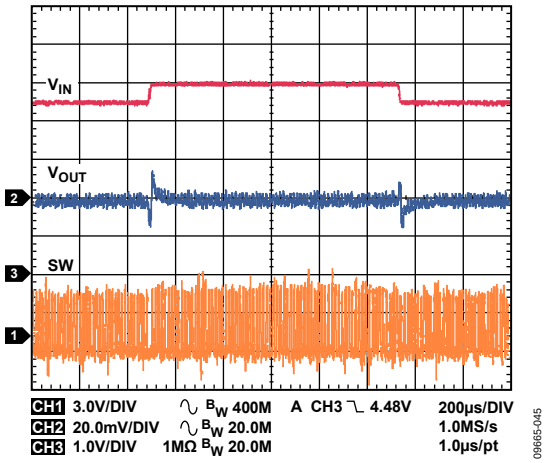


Figure 45. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 1.8 V, PWM Mode

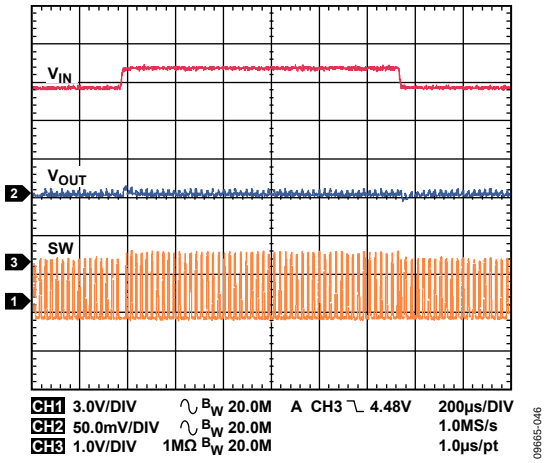


Figure 46. Buck Response to Line Transient, Input Voltage from 4.5 V to 5.0 V, V_{OUT1} = 1.2 V, PWM Mode

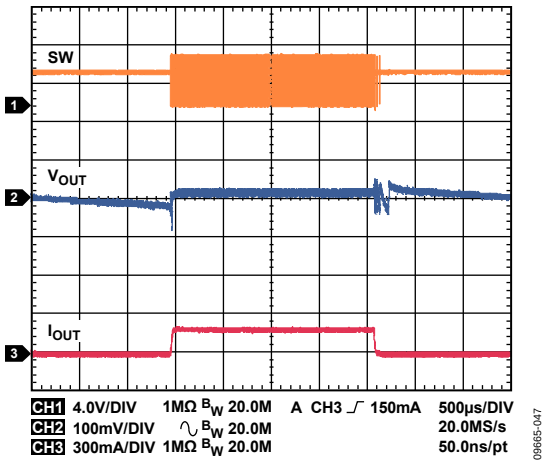


Figure 47. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 3.3 V, Auto Mode

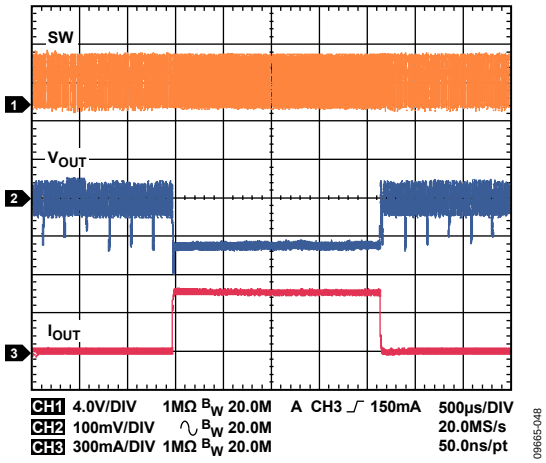


Figure 48. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 3.3 V, Auto Mode

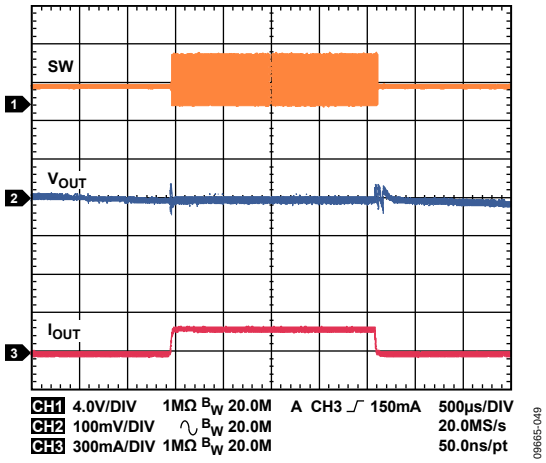


Figure 49. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 1.8 V, Auto Mode

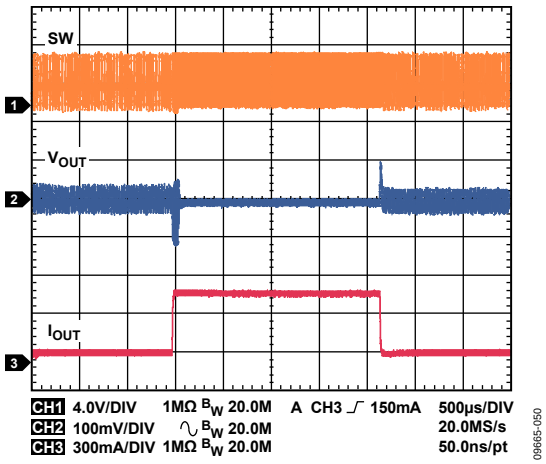


Figure 50. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 1.8 V, Auto Mode

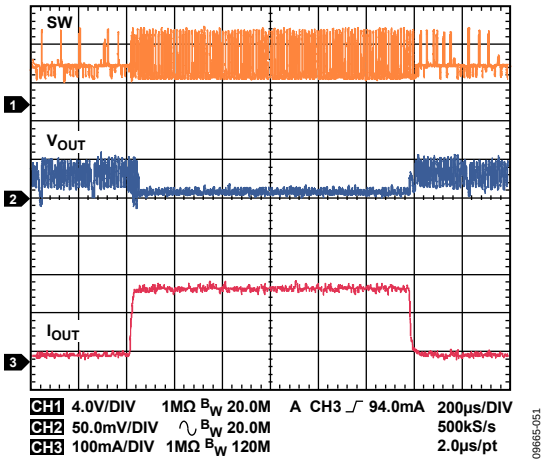


Figure 51. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 1.2 V, Auto Mode

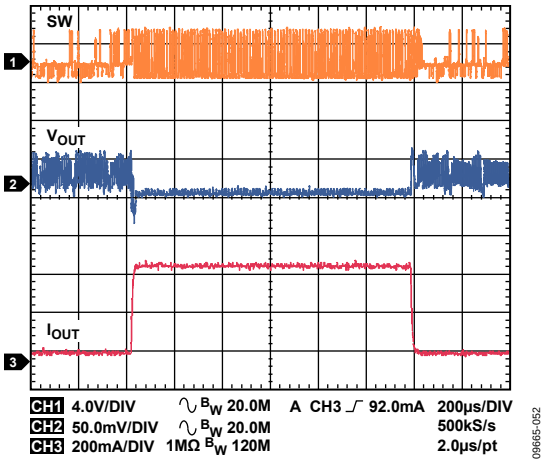


Figure 52. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 1.2 V, Auto Mode

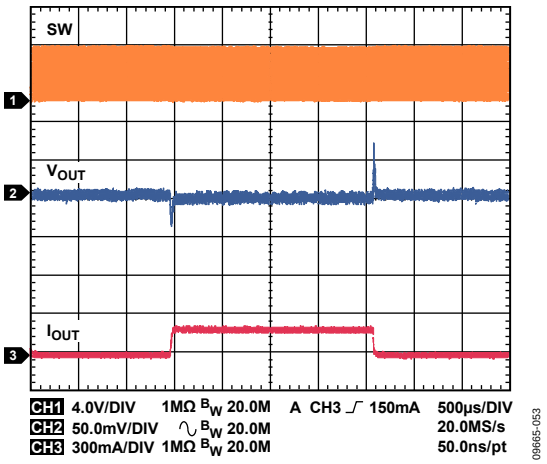


Figure 53. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 3.3 V, PWM Mode

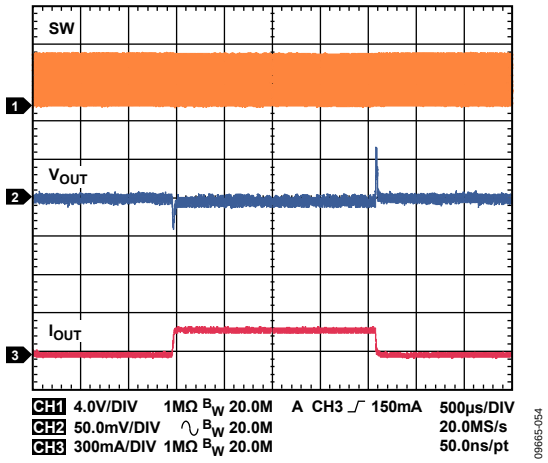


Figure 54. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 3.3 V, PWM Mode

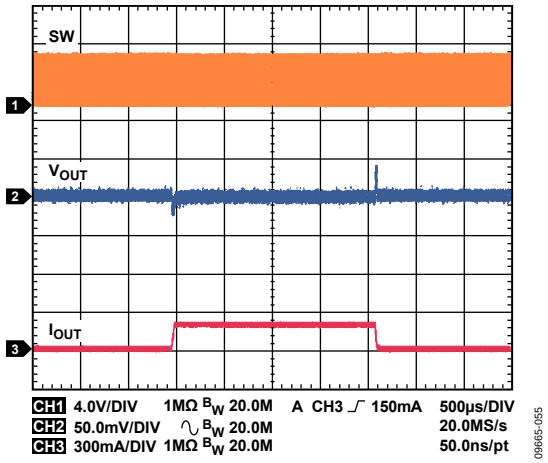


Figure 55. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 1.8 V, PWM Mode

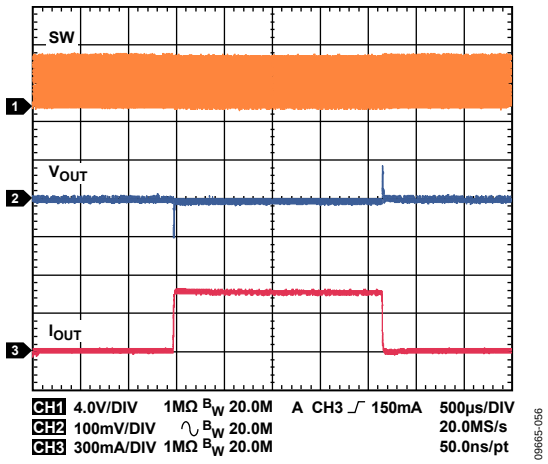


Figure 56. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 1.8 V, PWM Mode

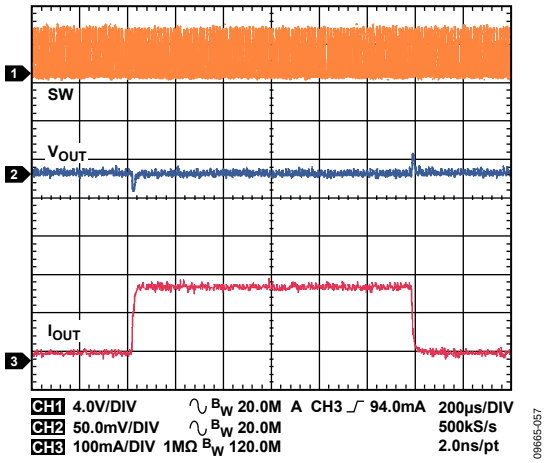


Figure 57. Buck Response to Load Transient, I_{OUT1} = 20 mA to 200 mA, V_{OUT1} = 1.2 V, PWM Mode

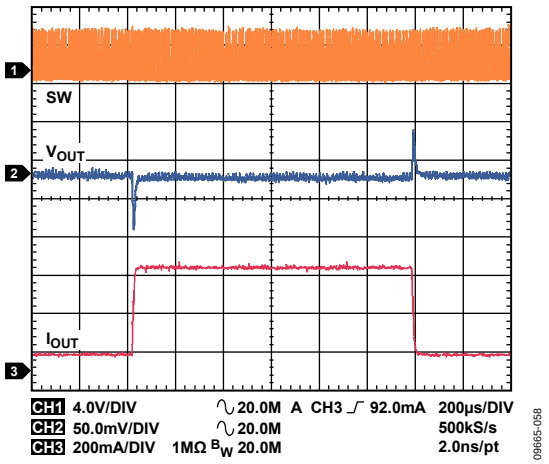


Figure 58. Buck Response to Load Transient, I_{OUT1} = 50 mA to 500 mA, V_{OUT1} = 1.2 V, PWM Mode

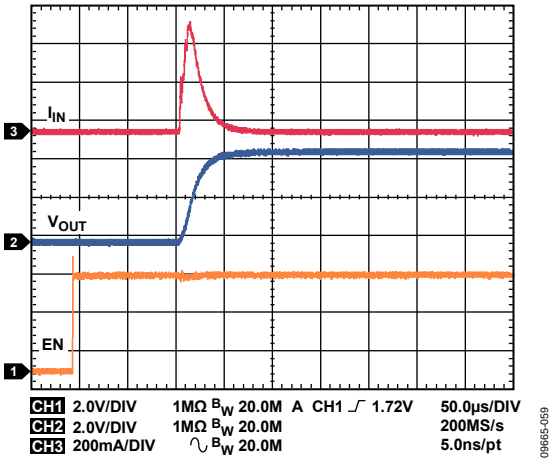


Figure 59. LDO1, LDO2 Startup, V_{OUT} = 4.7 V, I_{OUT} = 5 mA

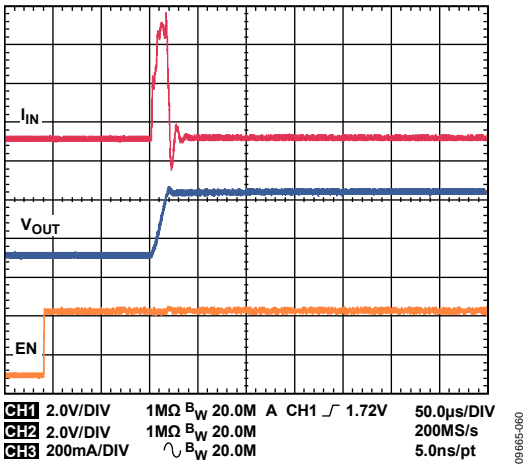


Figure 60. LDO1, LDO2 Startup, V_{OUT} = 3.3 V, I_{OUT} = 5 mA

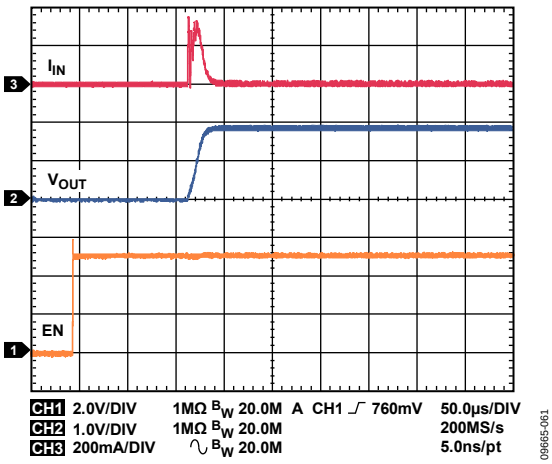


Figure 61. LDO1, LDO2 Startup, V_{OUT} = 1.8 V, I_{OUT} = 5 mA

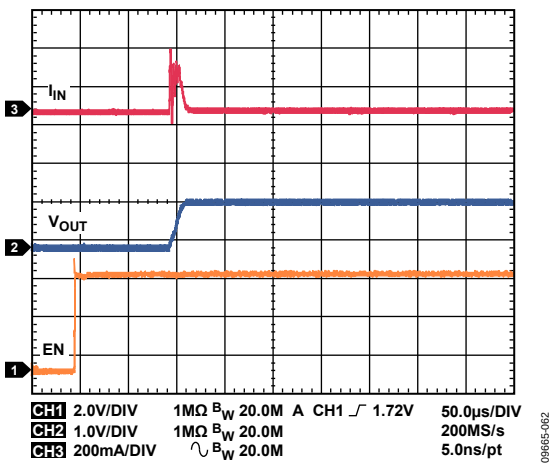


Figure 62. LDO1, LDO2 Startup, V_{OUT} = 1.2 V, I_{OUT} = 5 mA

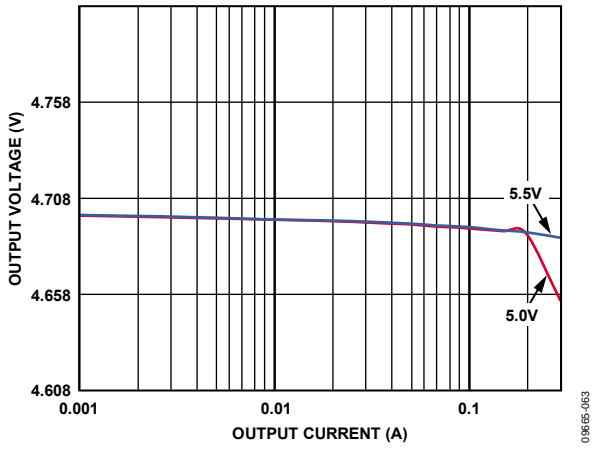


Figure 63. LDO1, LDO2 Load Regulation Across Input Voltage, V_{OUT} = 4.7 V

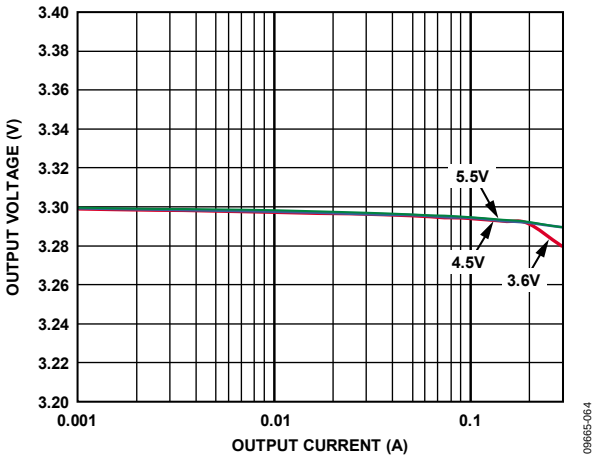


Figure 64. LDO1, LDO2 Load Regulation Across Input Voltage, V_{OUT} = 3.3 V

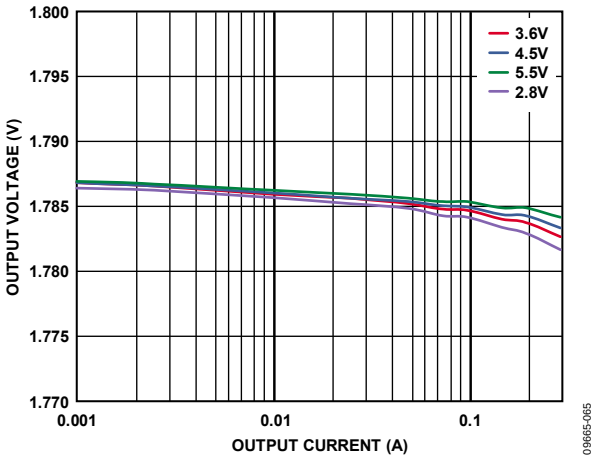


Figure 65. LDO1, LDO2 Load Regulation Across Input Voltage, V_{OUT} = 1.8 V

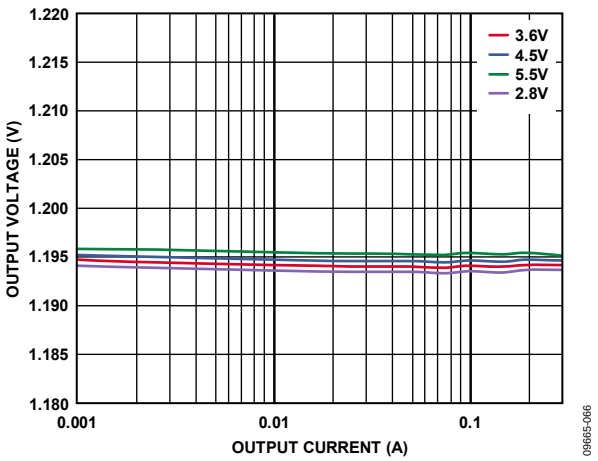


Figure 66. LDO1, LDO2 Load Regulation Across Input Voltage, V_{OUT} = 1.2 V

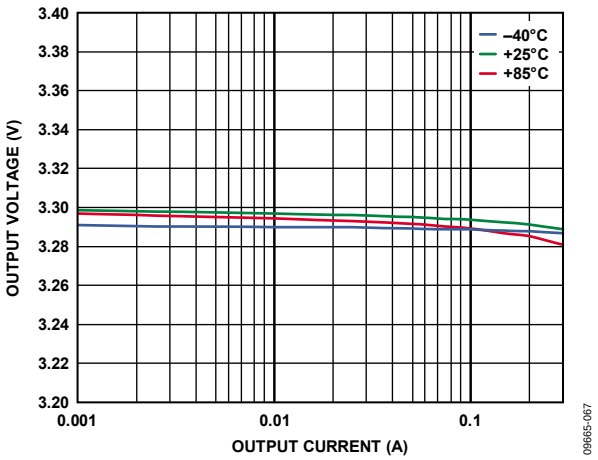


Figure 67. LDO1, LDO2 Load Regulation Across Temperature, V_{IN} = 3.6 V, V_{OUT} = 3.3 V

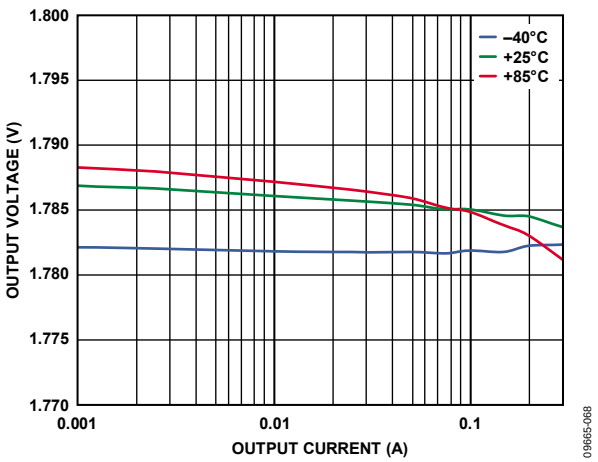


Figure 68. LDO1, LDO2 Load Regulation Across Temperature, V_{IN} = 3.6 V, V_{OUT} = 1.8 V

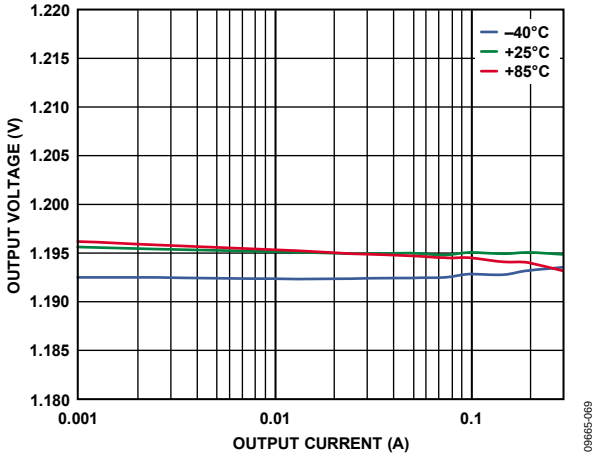


Figure 69. LDO1, LDO2 Load Regulation Across Temperature, V_{IN} = 3.6 V, V_{OUT} = 1.2 V

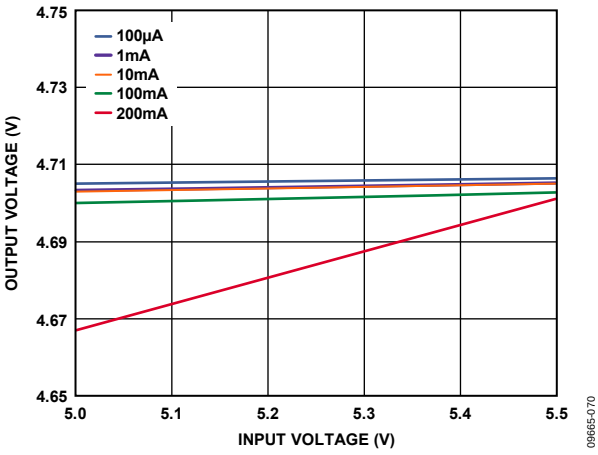


Figure 70. LDO1, LDO2 Line Regulation Across Input Voltage, V_{OUT} = 4.7 V

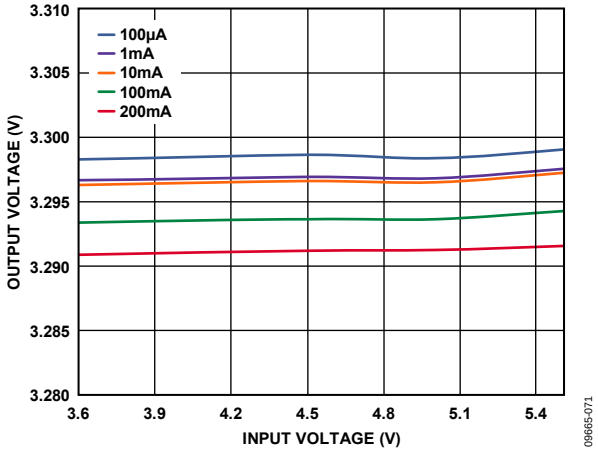


Figure 71. LDO1, LDO2 Line Regulation Across Input Voltage, V_{OUT} = 3.3 V

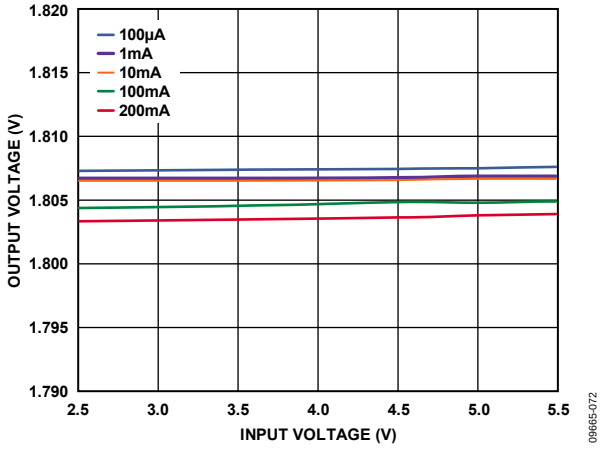


Figure 72. LDO1, LDO2 Line Regulation Across Input Voltage, V_{OUT} = 1.8 V

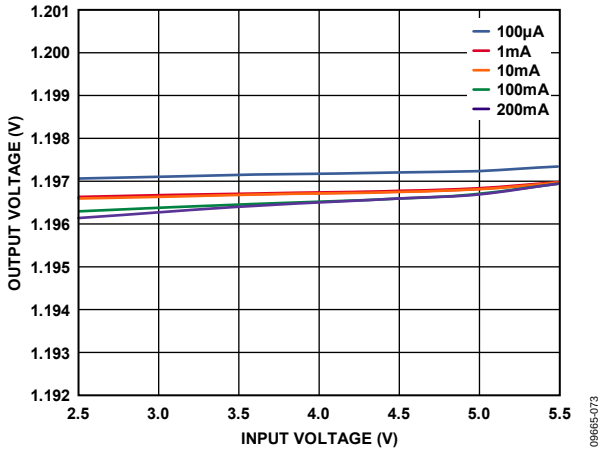


Figure 73. LDO1, LDO2 Line Regulation Across Input Voltage, V_{OUT} = 1.2 V

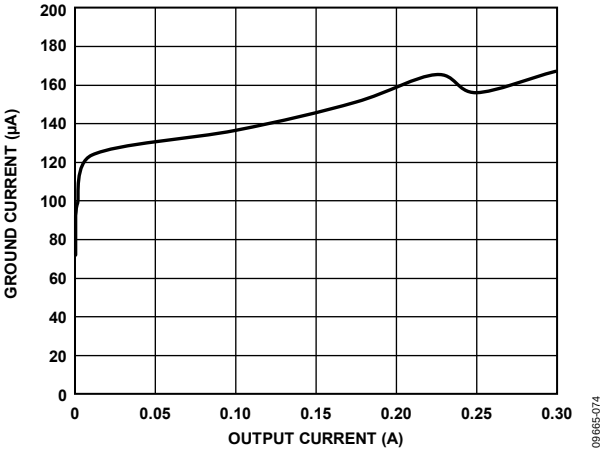


Figure 74. LDO1, LDO2 Ground Current vs. Output Current, V_{OUT} = 3.3 V

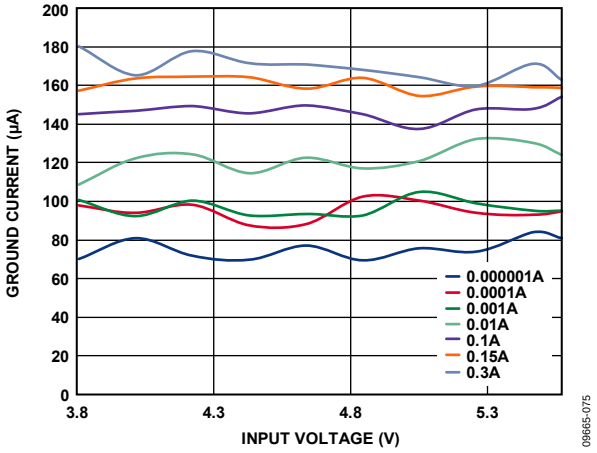


Figure 75. LDO1, LDO2 Ground Current vs. Input Voltage, Across Output Load (A), V_{OUT} = 3.3 V

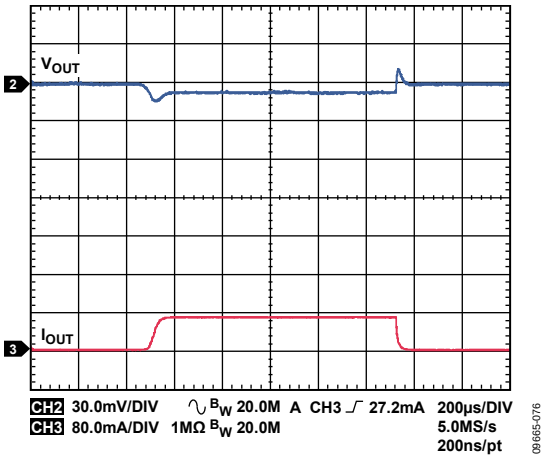


Figure 76. LDO1, LDO2 Response to Load Transient, I_{OUT} from 1 mA to 80 mA, V_{OUT} = 4.7 V

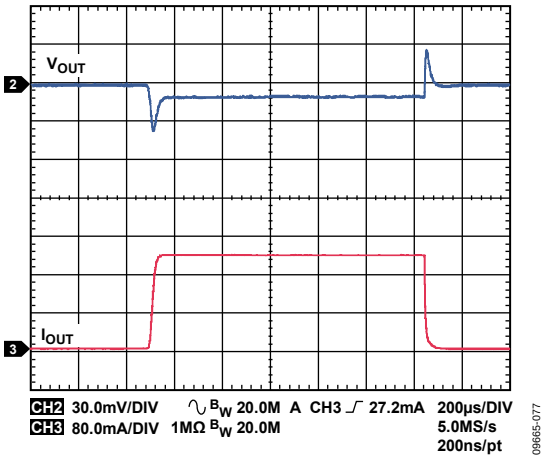


Figure 77. LDO1, LDO2 Response to Load Transient, I_{OUT} from 10 mA to 200 mA, V_{OUT} = 4.7 V

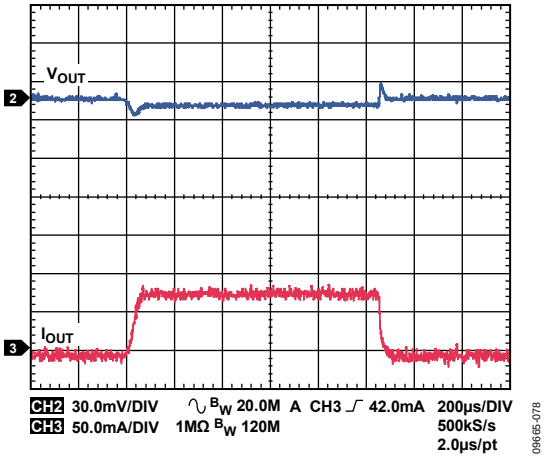


Figure 78. LDO1, LDO2 Response to Load Transient, I_{OUT} from 1 mA to 80 mA, V_{OUT} = 3.3 V

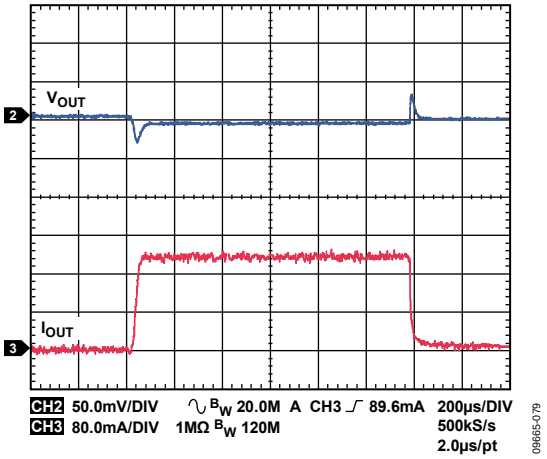


Figure 79. LDO1, LDO2 Response to Load Transient, I_{OUT} from 10 mA to 200 mA, V_{OUT} = 3.3 V

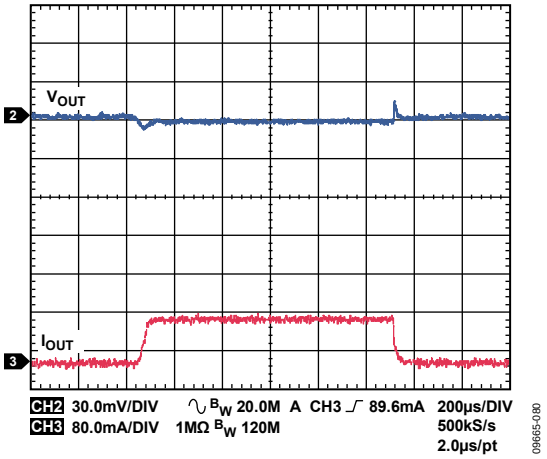


Figure 80. LDO1, LDO2 Response to Load Transient, I_{OUT} from 1 mA to 80 mA, V_{OUT} = 1.8 V

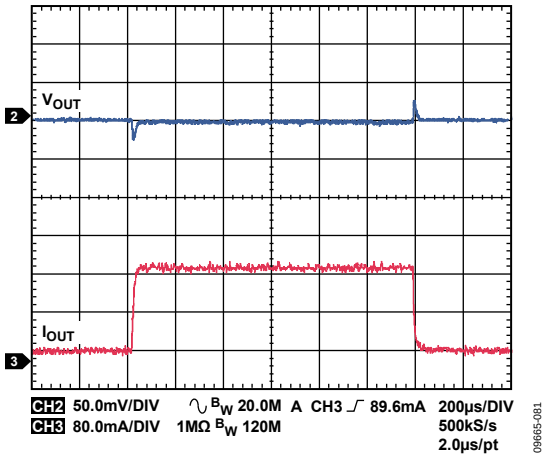


Figure 81. LDO1, LDO2 Response to Load Transient, I_{OUT} from 10 mA to 200 mA, V_{OUT} = 1.8 V

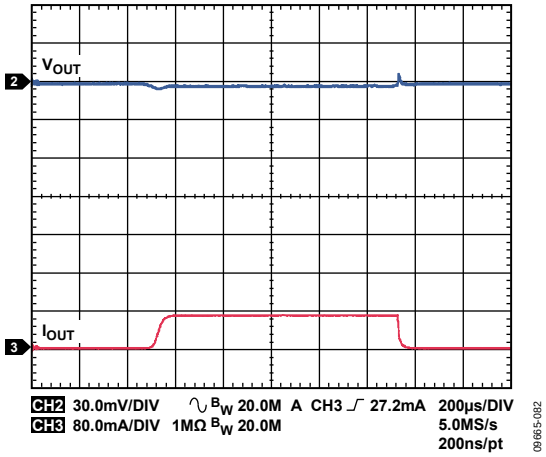


Figure 82. LDO1, LDO2 Response to Load Transient, I_{OUT} from 1 mA to 80 mA, V_{OUT} = 1.2 V

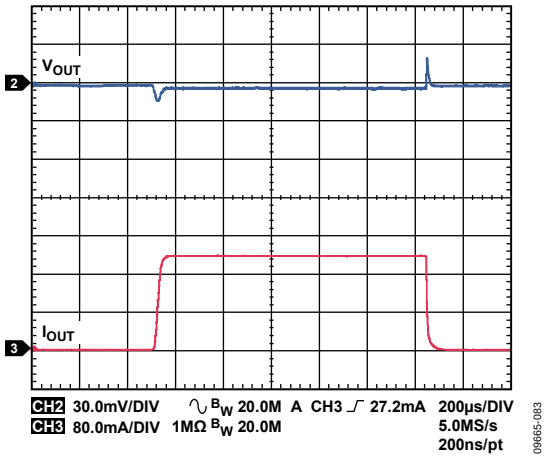


Figure 83. LDO1, LDO2 Response to Load Transient, I_{OUT} from 10 mA to 200 mA, V_{OUT} = 1.2 V

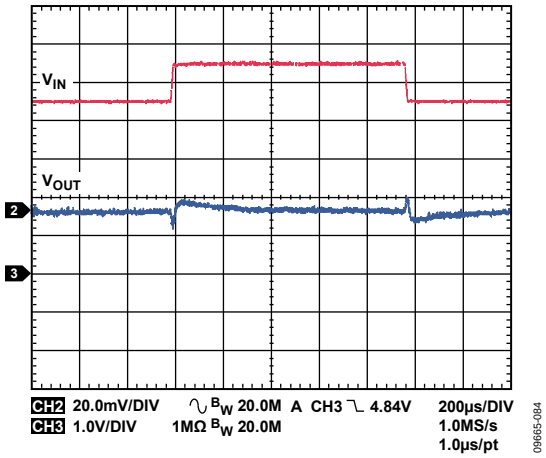


Figure 84. LDO1, LDO2 Response to Line Transient, Input Voltage from 4.5 V to 5.5 V, V_{OUT} = 3.3 V

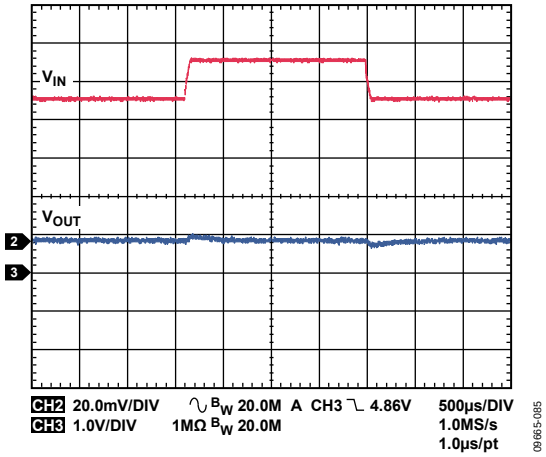


Figure 85. LDO1, LDO2 Response to Line Transient, Input Voltage from 4.5 V to 5.5 V, V_{OUT} = 1.8 V

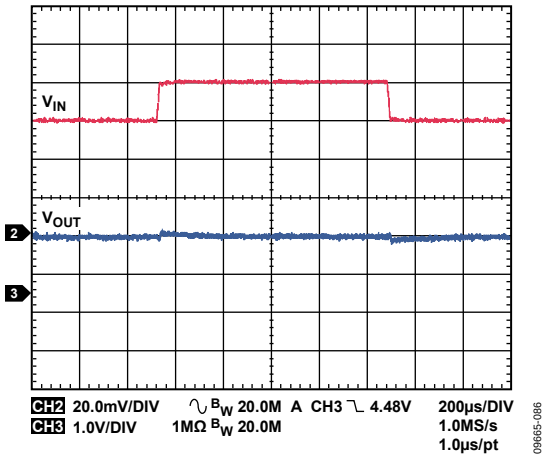


Figure 86. LDO1, LDO2 Response to Line Transient, Input Voltage from 4.5 V to 5.5 V, V_{OUT} = 1.2 V

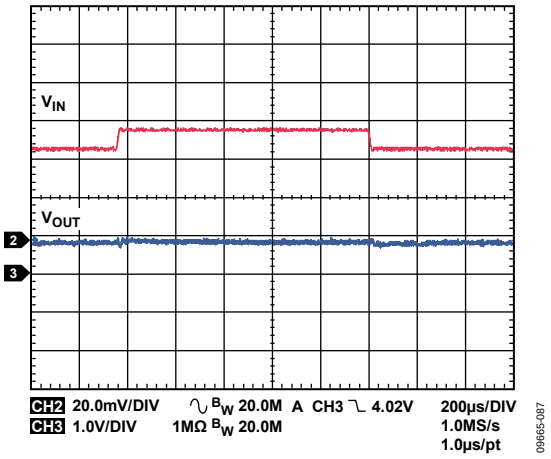


Figure 87. LDO1, LDO2 Response to Line Transient, Input Voltage from 3.3 V to 3.8 V, V_{OUT} = 1.8 V

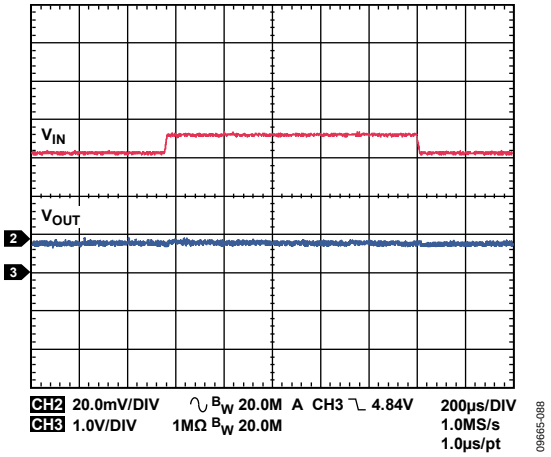


Figure 88. LDO1, LDO2 Response to Line Transient, Input Voltage from 3.3 V to 3.8 V, V_{OUT} = 1.2 V

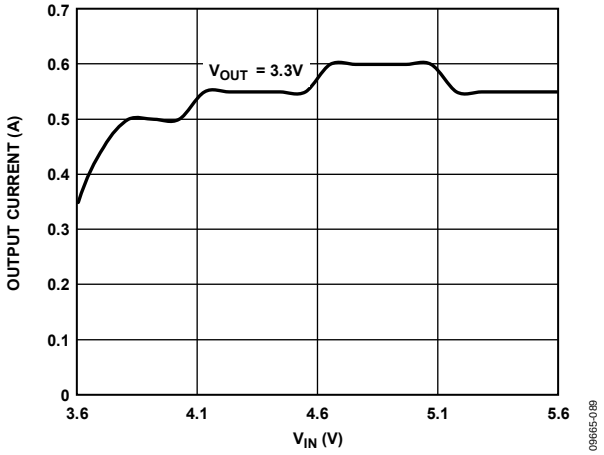


Figure 89. LDO1, LDO2 Output Current Capability vs. Input Voltage

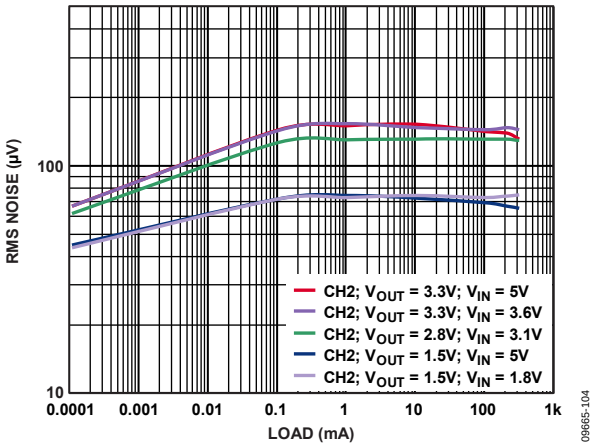


Figure 90. LDO1 Output Noise vs. Load Current, Across Input and Output Voltage

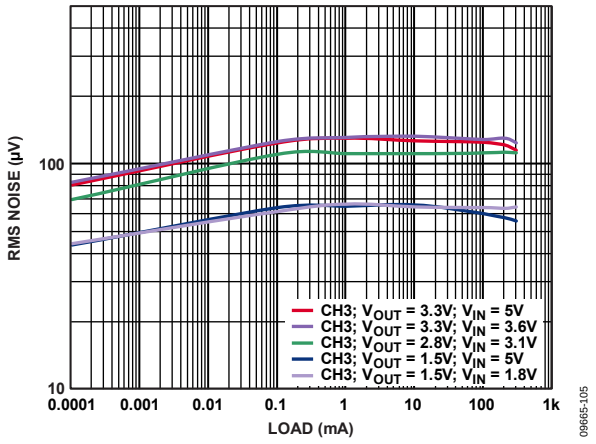


Figure 91. LDO2 Output Noise vs. Load Current, Across Input and Output Voltage

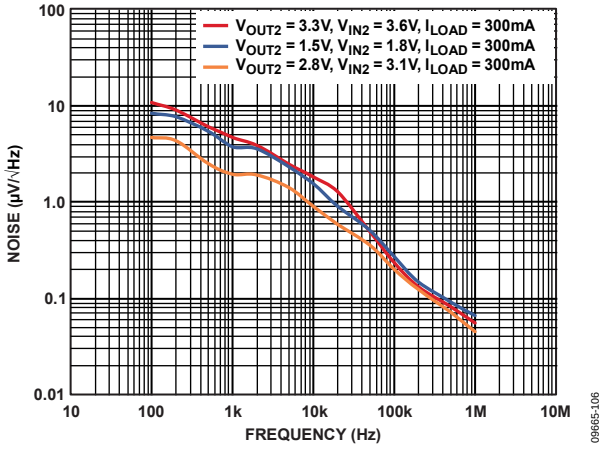


Figure 92. LDO1 Noise Spectrum Across Output Voltage, $V_{IN} = V_{OUT} + 0.3$ V

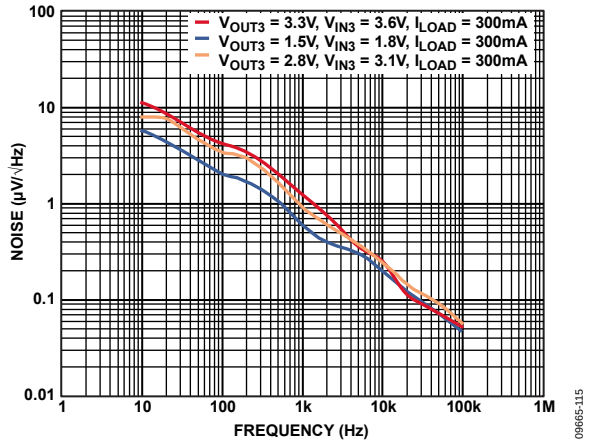


Figure 93. LDO2 Noise Spectrum Across Output Voltage, $V_{IN} = V_{OUT} + 0.3$ V

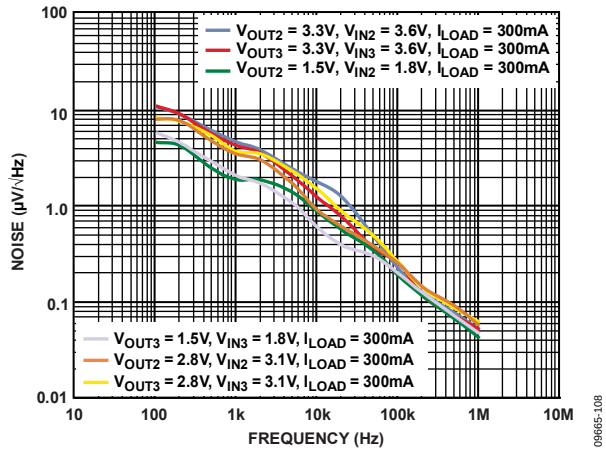


Figure 94. LDO1 vs. LDO2 Noise Spectrum

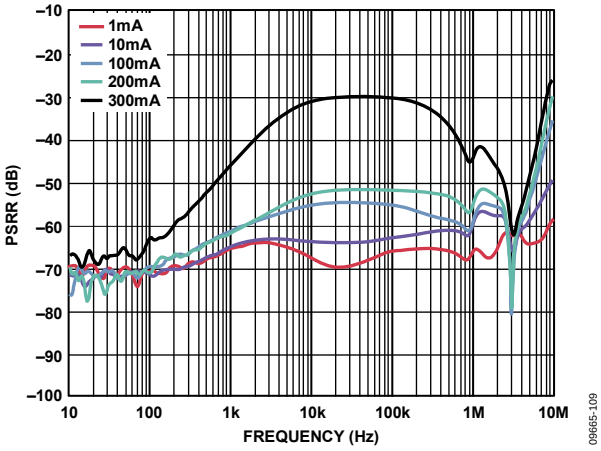


Figure 95. LDO2 PSRR Across Output Load, $V_{IN3} = 3.3$ V, $V_{OUT3} = 2.8$ V

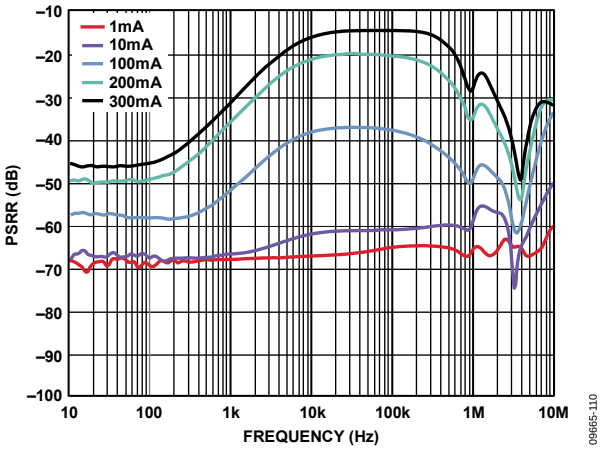


Figure 96. LDO2 PSRR Across Output Load, $V_{IN3} = 3.1$ V, $V_{OUT3} = 2.8$ V

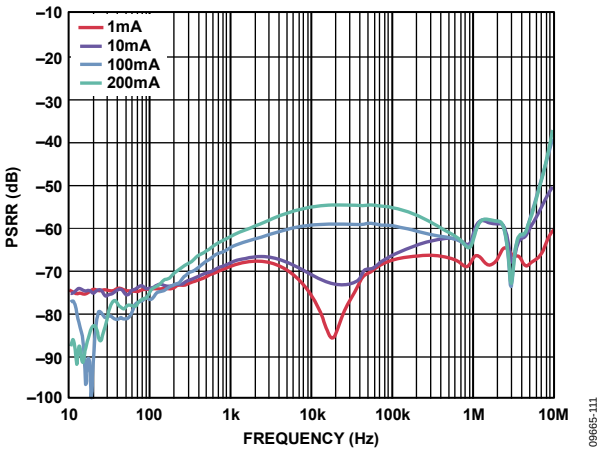


Figure 97. LDO2 PSRR Across Output Load, $V_{IN3} = 5.0$ V, $V_{OUT3} = 3.3$ V

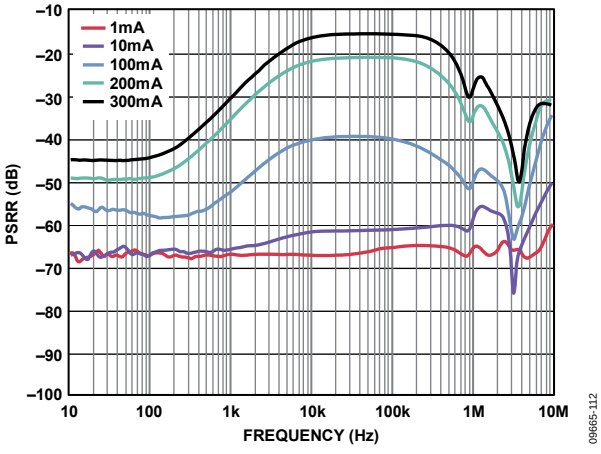


Figure 98. LDO2 PSRR Across Output Load, $V_{IN3} = 3.6$ V, $V_{OUT3} = 3.3$ V

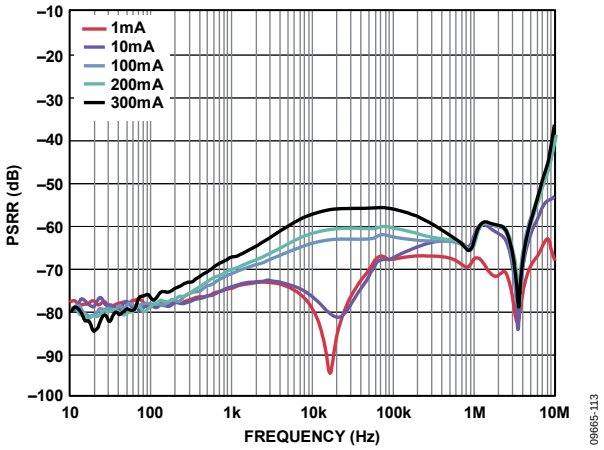


Figure 99. LDO1 PSRR Across Output Load, V_{IN2} = 5.0 V, V_{OUT2} = 1.5 V

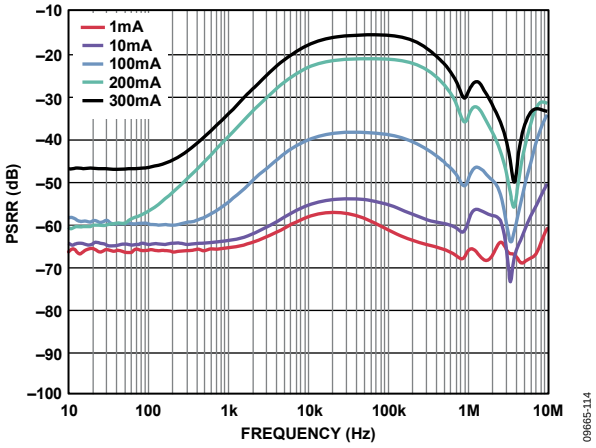


Figure 100. LDO1 PSRR Across Output Load, V_{IN2} = 1.8 V, V_{OUT2} = 1.5 V

THEORY OF OPERATION

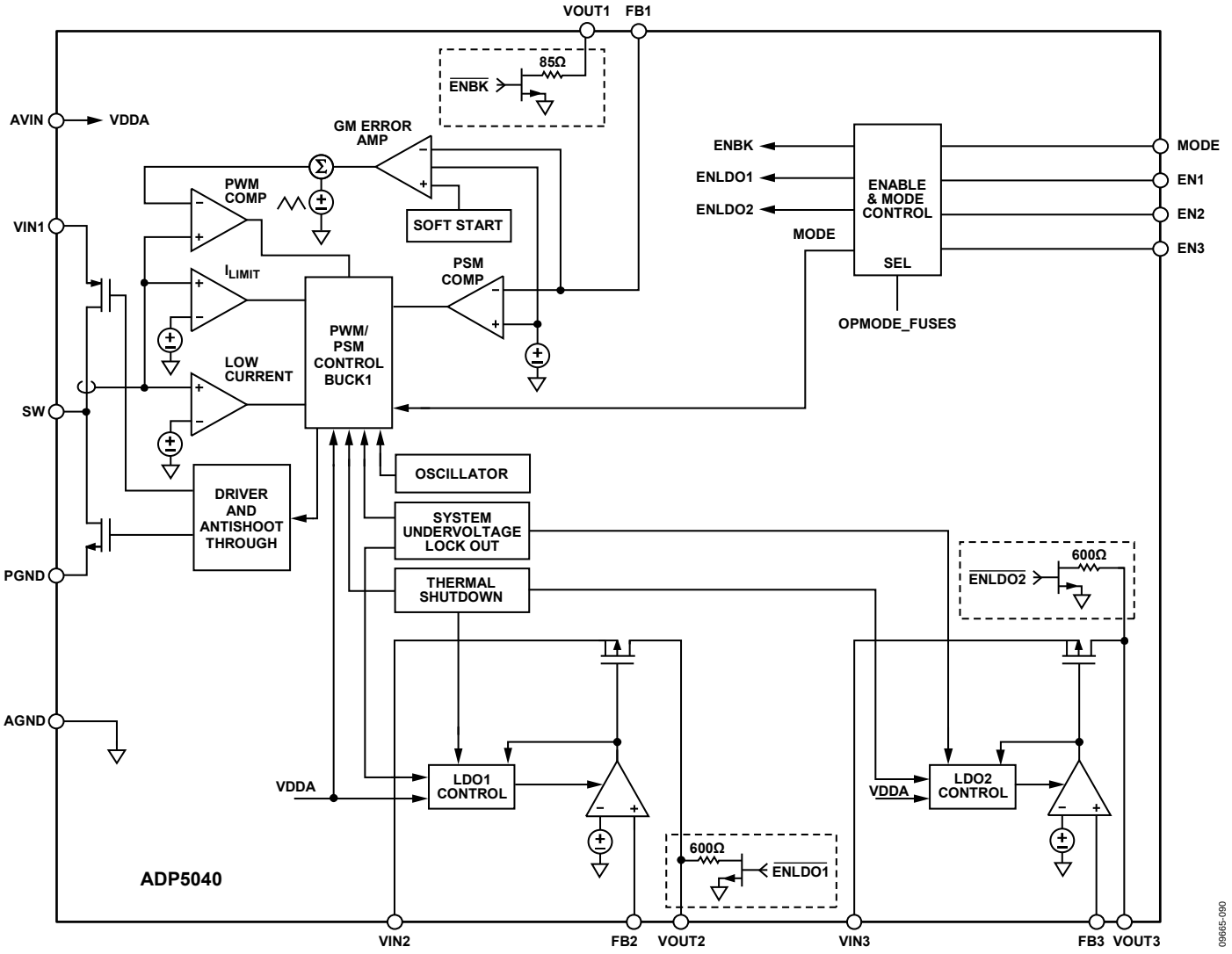


Figure 101. Functional Block Diagram

POWER MANAGEMENT UNIT

The ADP5040 is a micro power management unit (micro PMU) combing one step-down (buck) dc-to-dc regulator and two low dropout linear regulators (LDOs). The high switching frequency and tiny 20-pin LFCSP package allow for a small power management solution.

The regulators are activated by a logic level high applied to the respective EN pin. The EN1 pin controls the buck regulator, the EN2 pin controls LDO1, and the EN3 pin controls LDO2. The MODE pin controls the buck switching operation.

The regulator output voltages are set through external resistor dividers.

When a regulator is turned on, the output voltage ramp is controlled through a soft start circuit to avoid a large inrush current due to the discharged output capacitors.

The buck regulator can operate in forced PWM mode if the MODE pin is at a logic high level. In forced PWM mode, the switching frequency of the buck is always constant and does not change with the load current. If the MODE pin is at a logic low level, the switching regulator operates in auto PWM/PSM mode. In this mode, the regulator operates at fixed PWM frequency when the load current is above the power saving current threshold. When the load current falls below the power save current threshold, the regulator enters power saving mode, where the switching occurs in bursts. The burst repetition rate is a function of the current load and the output capacitor value. This operating mode reduces the switching and quiescent current losses.

Thermal Protection

In the event that the junction temperature rises above 150°C, the thermal shutdown circuit turns off the buck and the LDOs. Extreme junction temperatures can be the result of high current operation, poor circuit board design, or high ambient temperature. A 20°C hysteresis is included in the thermal shutdown circuit so that when thermal shutdown occurs, the buck and the LDOs do not return to normal operation until the on-chip temperature drops below 130°C. When coming out of thermal shutdown, all regulators start with soft start control.

Undervoltage Lockout

To protect against battery discharge, undervoltage lockout (UVLO) circuitry is integrated in the ADP5040. If the input voltage on AVIN drops below a typical 2.15 V UVLO threshold, all channels shut down. In the buck channel, both the power switch and the synchronous rectifier turn off. When the voltage on AVIN rises above the UVLO threshold, the part is enabled once more.

Alternatively, the user can select device models with a UVLO set at a higher level, suitable for 5 V applications. For these models, the device reaches the turn-off threshold when the input supply drops to 3.65 V typical.

Enable/Shutdown

The ADP5040 has individual control pins for each regulator. A logic level high applied to the ENx pin activates a regulator, whereas a logic level low turns off a regulator.

Active Pull-Down

The ADP5040 can be purchased with the active pull-down option enabled. The pull-down resistors are connected between each regulator output and AGND. The pull-downs are enabled, when the regulators are turned off. The typical value of the pull-down resistor is 600 Ω for the LDOs and 85 Ω for the buck.

BUCK SECTION

The buck uses a fixed frequency and high speed current mode architecture. The buck operates with an input voltage of 2.3 V to 5.5 V.

The buck output voltage is set though external resistor dividers, as shown in Figure 102. VOUT1 must be connected to the output capacitor. VFB1 is internally set to 0.5 V. The output voltage can be set from 0.8 V to 3.8 V.

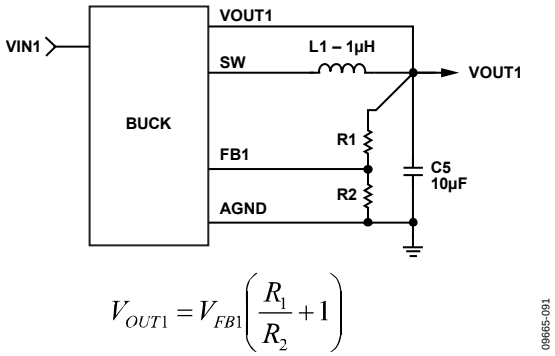


Figure 102. Buck External Output Voltage Setting

Control Scheme

The buck operates with a fixed frequency, current mode PWM control architecture at medium to high loads for high efficiency, but operation shifts to a power save mode (PSM) control scheme at light loads to lower the regulation power losses. When operating in fixed frequency PWM mode, the duty cycle of the integrated switches is adjusted and regulates the output voltage. When operating in PSM at light loads, the output voltage is controlled in a hysteretic manner, with higher output voltage ripple. During part of this time, the converter is able to stop switching and enters an idle mode, which improves conversion efficiency.

PWM Mode

In PWM mode, the buck operates at a fixed frequency of 3 MHz, set by an internal oscillator. At the start of each oscillator cycle, the PFET switch is turned on, sending a positive voltage across the inductor. Current in the inductor increases until the current sense signal crosses the peak inductor current threshold that turns off the PFET switch and turns on the NFET synchronous rectifier. This sends a negative voltage across the inductor, causing the inductor current to decrease. The synchronous rectifier stays on for the rest of the cycle. The buck regulates the output voltage by adjusting the peak inductor current threshold.

Power Save Mode (PSM)

The buck smoothly transitions to PSM operation when the load current decreases below the PSM current threshold. When the buck enters power save mode, an offset is introduced in the PWM regulation level, which makes the output voltage rise. When the output voltage reaches a level that is approximately 1.5% above the PWM regulation level, PWM operation is turned off. At this point, both power switches are off, and the buck enters an idle mode. The output capacitor discharges until the output voltage falls to the PWM regulation voltage, at which point the device drives the inductor to make the output voltage rise again to the upper threshold. This process is repeated while the load current is below the PSM current threshold.

The ADP5040 has a dedicated MODE pin controlling the PSM and PWM operation. A high logic level applied to the MODE pin forces the buck to operate in PWM mode. A logic level low sets the buck to operate in auto PSM/PWM.

PSM Current Threshold

The PSM current threshold is set to 100 mA. The buck employs a scheme that enables this current to remain accurately controlled, independent of input and output voltage levels. This scheme also ensures that there is very little hysteresis between the PSM current threshold for entry to, and exit from, the PSM mode. The PSM current threshold is optimized for excellent efficiency over all load currents.

Short-Circuit Protection

The buck includes frequency foldback to prevent current runaway on a hard short at the output. When the voltage at the feedback pin falls below half the internal reference voltage, indicating the possibility of a hard short at the output, the switching frequency is reduced to half the internal oscillator frequency. The reduction in the switching frequency allows more time for the inductor to discharge, preventing a runaway of output current.

Soft Start

The buck has an internal soft start function that ramps the output voltage in a controlled manner upon startup, thereby limiting the inrush current. This prevents possible input voltage drops when a battery or a high impedance power source is connected to the input of the converter.

Current Limit

The buck has protection circuitry to limit the amount of positive current flowing through the PFET switch and the amount of negative current flowing through the synchronous rectifier. The positive current limit on the power switch limits the amount of current that can flow from the input to the output. The negative current limit prevents the inductor current from reversing direction and flowing out of the load.

100% Duty Operation

With a dropping input voltage or with an increase in load current, the buck may reach a limit where, even with the PFET switch on 100% of the time, the output voltage drops below the desired output voltage. At this limit, the buck transitions to a mode where the PFET switch stays on 100% of the time. When the input conditions change again and the required duty cycle falls, the buck immediately restarts PWM regulation without allowing overshoot on the output voltage.

LDO SECTION

The ADP5040 contains two LDOs with low quiescent current that provide output currents up to 300 mA. The low 10 µA typical quiescent current at no load makes the LDO ideal for battery-operated portable equipment.

The LDOs operate with an input voltage range of 1.7 V to 5.5 V. The wide operating range makes these LDOs suitable for cascade configurations where the LDO supply voltage is provided from the buck regulator.

Each LDO output voltage is set though external resistor dividers as shown in Figure 103. V_{FB2} and V_{FB3} are internally set to 0.5 V. The output voltage can be set from 0.8 V to 5.2 V.

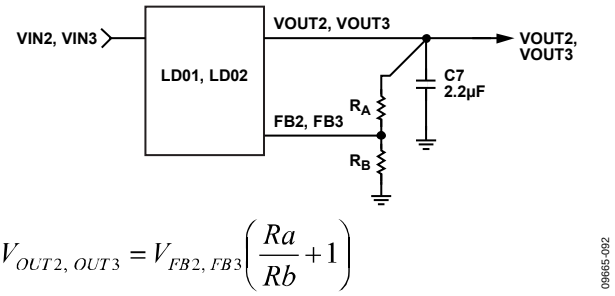


Figure 103. LDOs External Output Voltage Setting

The LDOs also provide high power supply rejection ratio (PSRR), low output noise, and excellent line and load transient response with small 1 µF ceramic input and output capacitors.

LDO2 is optimized to supply analog circuits because it offers better noise performance compared to LDO1. LDO1 should be used in applications where noise performance is not critical.

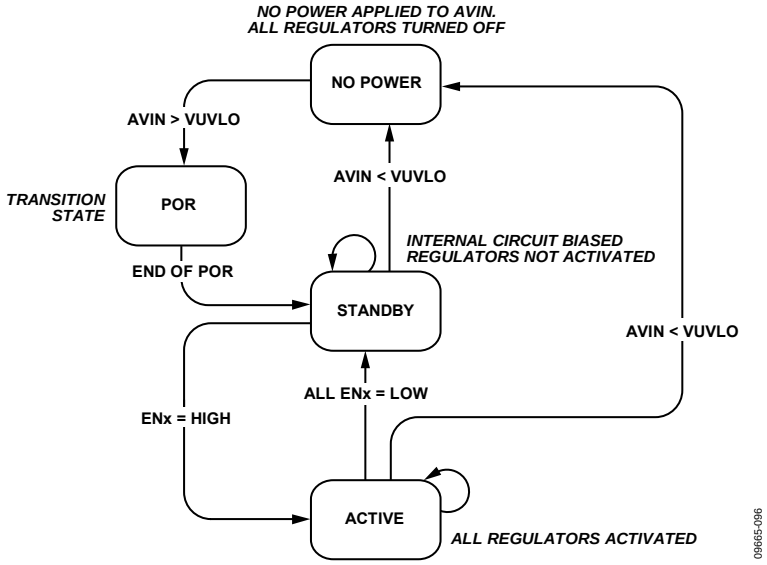


Figure 104. ADP5040 State Flow

APPLICATIONS INFORMATION

BUCK EXTERNAL COMPONENT SELECTION

Trade-offs between performance parameters such as efficiency and transient response are made by varying the choice of external components in the applications circuit, as shown in Figure 1.

Feedback Resistors

Referring to Figure 102, the total combined resistance for R1 and R2 is not to exceed 400 kΩ.

Inductor

The high switching frequency of the ADP5040 buck allows for the selection of small chip inductors. For best performance, use inductor values between 0.7 µH and 3.0 µH. Suggested inductors are shown in Table 8.

The peak-to-peak inductor current ripple is calculated using the following equation:

$$I_{RIPPLE} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times L}$$

where:
f_{SW} is the switching frequency.
L is the inductor value.

The minimum dc current rating of the inductor must be greater than the inductor peak current. The inductor peak current is calculated using the following equation:

$$I_{PEAK} = I_{LOAD(MAX)} + \frac{I_{RIPPLE}}{2}$$

Table 8. Suggested 1.0 µH Inductors

Vendor	Model	Dimensions (mm)	I_{SAT} (mA)	DCR (mΩ)
Murata	LQM2MPN1R0NG0B	2.0 × 1.6 × 0.9	1400	85
Murata	LQM18FN1R0M00B	3.2 × 2.5 × 1.5	2300	54
Tayo Yuden	CBC322ST1R0MR	3.2 × 2.5 × 2.5	2000	71
Coilcraft	XFL4020-102ME	4.0 × 4.0 × 2.1	5400	11
Coilcraft	XPL2010-102ML	1.9 × 2.0 × 1.0	1800	89
Toko	MDT2520-CN	2.5 × 2.0 × 1.2	1350	85

Inductor conduction losses are caused by the flow of current through the inductor, which has an associated internal dc resistance (DCR). Larger sized inductors have smaller DCR, which may decrease inductor conduction losses. Inductor core losses are related to the magnetic permeability of the core material. Because the buck is high switching frequency dc-to-dc converter, shielded ferrite core material is recommended for its low core losses and low EMI.

Output Capacitor

Higher output capacitor values reduce the output voltage ripple and improve load transient response. When choosing the capacitor value, it is also important to account for the loss of capacitance due to output voltage dc bias.

Ceramic capacitors are manufactured with a variety of dielectrics, each with a different behavior over temperature and applied voltage. Capacitors must have a dielectric adequate to ensure the minimum capacitance over the necessary temperature range and dc bias conditions. X5R or X7R dielectrics with a voltage rating of 6.3 V or 10 V are highly recommended for best performance. Y5V and Z5U dielectrics are not recommended for use with any dc-to-dc converter because of their poor temperature and dc bias characteristics.

The worst-case capacitance accounting for capacitor variation over temperature, component tolerance, and voltage is calculated using the following equation:

$$C_{EFF} = C_{OUT} \times (1 - TEMPCO) \times (1 - TOL)$$

where:
C_{EFF} is the effective capacitance at the operating voltage.
$TEMPCO$ is the worst-case capacitor temperature coefficient.
TOL is the worst-case component tolerance.

In this example, the worst-case temperature coefficient (TEMPCO) over −40°C to +85°C is assumed to be 15% for an X5R dielectric. The tolerance of the capacitor (TOL) is assumed to be 10%, and C_{OUT} is 9.2481 µF at 1.8 V, as shown in Figure 105.

Substituting these values in the equation yields

$$C_{EFF} = 9.24\ \mu F \times (1 - 0.15) \times (1 - 0.1) = 7.07\ \mu F$$

To guarantee the performance of the buck, it is imperative that the effects of dc bias, temperature, and tolerances on the behavior of the capacitors be evaluated for each application.

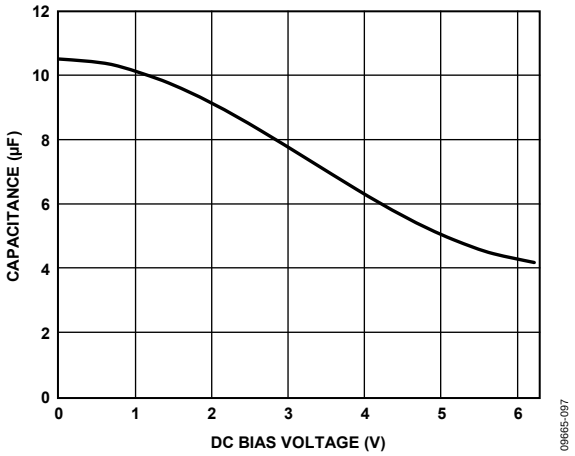


Figure 105. Typical Capacitor Performance

The peak-to-peak output voltage ripple for the selected output capacitor and inductor values is calculated using the following equation:

$$V_{RIPPLE} = \frac{I_{RIPPLE}}{8 \times f_{SW} \times C_{OUT}} \approx \frac{V_{IN}}{(2\pi \times f_{SW})^2 \times L \times C_{OUT}}$$

Capacitors with lower equivalent series resistance (ESR) are preferred to guarantee low output voltage ripple, as shown in the following equation:

$$ESR_{COUT} \leq \frac{V_{RIPPLE}}{I_{RIPPLE}}$$

The effective capacitance needed for stability, which includes temperature and dc bias effects, is a minimum of 7 µF and a maximum of 40 µF.

Table 9. Suggested 10 µF Capacitors

Vendor	Type	Model	Case Size	Voltage Rating (V)
Murata	X5R	GRM188R60J106	0603	6.3
Taiyo Yuden	X5R	JMK107BJ106MA-T	0603	6.3
TDK	X5R	C1608JB0J106K	0603	6.3
Panasonic	X5R	ECJ1VB0J106M	0603	6.3

The buck regulator requires 10 µF output capacitors to guarantee stability and response to rapid load variations and to transition in and out the PWM/PSM modes. In certain applications, where the buck regulator powers a processor, the operating state is known because it is controlled by software. In this condition, the processor can drive the MODE pin according to the operating state; consequently, it is possible to reduce the output capacitor from 10 µF to 4.7 µF because the regulator does not expect a large load variation when working in PSM mode (see Figure 106).

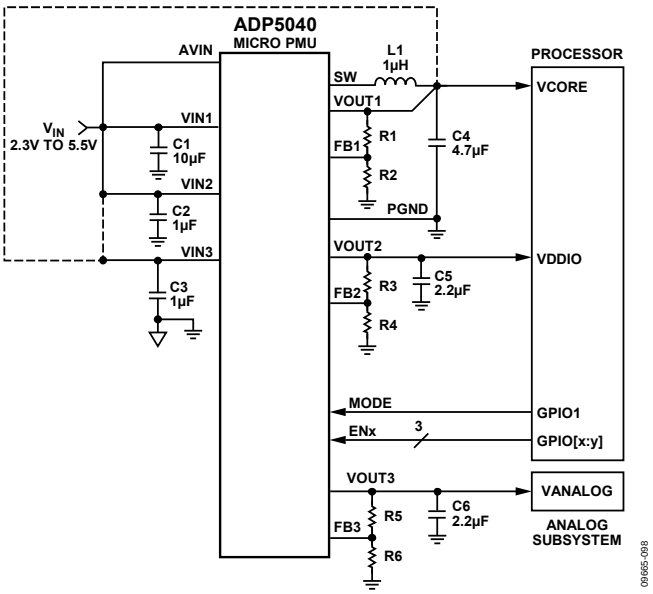


Figure 106. Processor System Power Management with PSM/PWM Control

Input Capacitor

A higher value input capacitor helps to reduce the input voltage ripple and improve transient response. Maximum input capacitor current is calculated using the following equation:

$$I_{CIN} \geq I_{LOAD(MAX)} \sqrt{\frac{V_{OUT}(V_{IN} - V_{OUT})}{V_{IN}}}$$

To minimize supply noise, place the input capacitor as close to the VIN pin of the buck as possible. As with the output capacitor, a low ESR capacitor is recommended.

The effective capacitance needed for stability, which includes temperature and dc bias effects, is a minimum of 3 µF and a maximum of 10 µF. A list of suggested capacitors is shown in Table 10.

Table 10. Suggested 4.7 µF Capacitors

Vendor	Type	Model	Case Size	Voltage Rating (V)
Murata	X5R	GRM188R60J475ME19D	0603	6.3
Taiyo Yuden	X5R	JMK107BJ475	0603	6.3
Panasonic	X5R	ECJ-0EB0J475M	0402	6.3

LDO EXTERNAL COMPONENT SELECTION

Feedback Resistors

Referring to Figure 103, the maximum value of R_B is not to exceed 200 kΩ.

Output Capacitor

The ADP5040 LDOs are designed for operation with small, space-saving ceramic capacitors, but they function with most commonly used capacitors as long as care is taken with the ESR value. The ESR of the output capacitor affects stability of the LDO control loop. A minimum of 0.70 µF capacitance with an ESR of 1 Ω or less is recommended to ensure stability of the LDO. Transient response to changes in load current is also affected by output capacitance. Using a larger value of output capacitance improves the transient response of the LDO to large changes in load current.

When operating at output currents higher than 200 mA a minimum of 2.2 µF capacitance with an ESR of 1 Ω or less is recommended to ensure stability of the LDO.

Table 11. Suggested 2.2 µF Capacitors

Vendor	Type	Model	Case Size	Voltage Rating (V)
Murata	X5R	GRM188B31A225K	0402	10.0
TDK	X5R	C1608JB0J225KT	0402	6.3
Panasonic	X5R	ECJ1VB0J225K	0402	6.3
Taiyo Yuden	X5R	JMK107BJ225KK-T	0402	6.3

Input Bypass Capacitor

Connecting 1 µF capacitors from VIN2 and VIN3 to ground reduces the circuit sensitivity to the PCB layout, especially when long input traces or high source impedance is encountered. If greater than 1 µF of output capacitance is required, increase the input capacitor to match it.

Table 12. Suggested 1.0 µF Capacitors

Vendor	Type	Model	Case Size	Voltage Rating (V)
Murata	X5R	GRM155R61A105ME15	0402	10.0
TDK	X5R	C1005JB0J105KT	0402	6.3
Panasonic	X5R	ECJ0EB0J105K	0402	6.3
Taiyo Yuden	X5R	LMK105BJ105MV-F	0402	10.0

Input and Output Capacitor Properties

Use any good quality ceramic capacitor with the ADP5040 as long as it meets the minimum capacitance and maximum ESR requirements. Ceramic capacitors are manufactured with a variety of dielectrics, each with a different behavior over temperature and applied voltage. Capacitors must have a dielectric adequate to ensure the minimum capacitance over the necessary temperature range and dc bias conditions. X5R or X7R dielectrics with a voltage rating of 6.3 V or 10 V are recommended for best performance. Y5V and Z5U dielectrics are not recommended for use with any LDO because of their poor temperature and dc bias characteristics.

Figure 107 depicts the capacitance vs. voltage bias characteristic of a 0402 1 µF, 10 V, X5R capacitor. The voltage stability of a capacitor is strongly influenced by the capacitor size and voltage rating. In general, a capacitor in a larger package or higher voltage rating exhibits better stability. The temperature variation of the X5R dielectric is about ±15% over the −40°C to +85°C temperature range and is not a function of package or voltage rating.

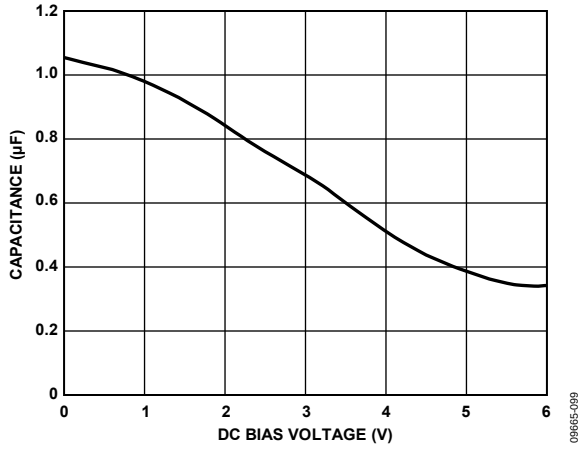


Figure 107. Capacitance vs. Voltage Characteristic

Use the following equation to determine the worst-case capacitance accounting for capacitor variation over temperature, component tolerance, and voltage.

$$C_{EFF} = C_{BIAS} \times (1 - TEMPCO) \times (1 - TOL)$$

where:
C_{BIAS} is the effective capacitance at the operating voltage.
TEMPCO is the worst-case capacitor temperature coefficient.
TOL is the worst-case component tolerance.

In this example, the worst-case temperature coefficient (TEMPCO) over −40°C to +85°C is assumed to be 15% for an X5R dielectric. The tolerance of the capacitor (TOL) is assumed to be 10%, and C_{BIAS} is 0.94 µF at 1.8 V as shown in Figure 107.

Substituting these values into the following equation yields:

$$C_{EFF} = 0.94\ \mu F \times (1 - 0.15) \times (1 - 0.1) = 0.72\ \mu F$$

Therefore, the capacitor chosen in this example meets the minimum capacitance requirement of the LDO over temperature and tolerance at the chosen output voltage.

To guarantee the performance of the ADP5040, it is imperative that the effects of dc bias, temperature, and tolerances on the behavior of the capacitors be evaluated for each application.

POWER DISSIPATION/THERMAL CONSIDERATIONS

The ADP5040 is a highly efficient micropower management unit (micro PMU), and in most cases the power dissipated in the device is not a concern. However, if the device operates at high ambient temperatures and with maximum loading conditions, the junction temperature can reach the maximum allowable operating limit (125°C).

When the junction temperature exceeds 150°C, the ADP5040 turns off all the regulators, allowing the device to cool down. Once the die temperature falls below 135°C, the ADP5040 resumes normal operation.

This section provides guidelines to calculate the power dissipated in the device and to make sure the ADP5040 operates below the maximum allowable junction temperature.

The efficiency for each regulator on the ADP5040 is given by

$$\eta = \frac{P_{OUT}}{P_{IN}} \times 100\% \quad (1)$$

where:
η is efficiency.
P_{IN} is the input power.
P_{OUT} is the output power.

Power loss is given by

$$P_{LOSS} = P_{IN} - P_{OUT} \quad (2a)$$

or

$$P_{LOSS} = P_{OUT} \times (1 - \eta)/\eta \quad (2b)$$

Power dissipation can be calculated in several ways. The most intuitive and practical way is to measure the power dissipated at the input and all the outputs. The measurements should be performed at the worst-case conditions (voltages, currents, and temperature). The difference between input and output power is dissipated in the device and the inductor. Use Equation 4 to derive the power lost in the inductor, and from this use Equation 3 to calculate the power dissipation in the ADP5040 buck regulator.

A second method to estimate the power dissipation uses the efficiency curves provided for the buck regulator, whereas the power lost on a LDO is calculated using Equation 12. When the buck efficiency is known, use Equation 2b to derive the total power lost in the buck regulator and inductor. Use Equation 4

to derive the power lost in the inductor, and then calculate the power dissipation in the buck converter using Equation 3. Add the power dissipated in the buck and in the LDOs to find the total dissipated power.

Note that the buck efficiency curves are typical values and may not be provided for all possible combinations of V_{IN}, V_{OUT}, and I_{OUT}. To account for these variations, it is necessary to include a safety margin when calculating the power dissipated in the buck.

A third way to estimate the power dissipation is analytical and involves modeling the losses in the buck circuit provided by Equation 8 to Equation 11 and the losses in the LDOs provided by Equation 12.

Buck Regulator Power Dissipation

The power loss of the buck regulator is approximated by

$$P_{LOSS} = P_{DBUCK} + P_L \quad (3)$$

where:
P_{DBUCK} is the power dissipation on the ADP5040 buck regulator.
P_L is the inductor power losses.

The inductor losses are external to the device and they do not have any effect on the die temperature.

The inductor losses are estimated (without core losses) by

$$P_L \cong I_{OUT1(RMS)}{}^2 \times DCR_L \quad (4)$$

where:

DCR_L is the inductor series resistance.
$I_{OUT1(RMS)}$ is the rms load current of the buck regulator.

$$I_{OUT1(RMS)} = I_{OUT1} \times \sqrt{1 + r/12} \quad (5)$$

where r is the normalized inductor ripple current.

$$R \approx V_{OUT1} \times (1 - D)/(I_{OUT1} \times L \times f_{SW}) \quad (6)$$

where:

L is inductance.
F_{SW} is switching frequency.
D is duty cycle.

$$D = V_{OUT1}/V_{IN1} \quad (7)$$

The ADP5040 buck regulator power dissipation, P_{DBUCK}, includes the power switch conductive losses, the switch losses, and the transition losses of each channel. There are other sources of loss, but these are generally less significant at high output load currents, where the thermal limit of the application is. Equation 8 shows the calculation made to estimate the power dissipation in the buck regulator.

$$P_{DBUCK} = P_{COND} + P_{SW} + P_{TRAN} \quad (8)$$

The power switch conductive losses are due to the output current, I_{OUT1}, flowing through the PMOSFET and the NMOSFET power switches that have internal resistance, R_{DSON-P} and R_{DSON-N}. The amount of conductive power loss is found by:

$$P_{COND} = [R_{DSON-P} \times D + R_{DSON-N} \times (1 - D)] \times I_{OUT1}{}^2 \quad (9)$$

For the ADP5040, at 125°C junction temperature and V_{IN1} = 3.6 V, R_{DSON-P} is approximately 0.2 Ω, and R_{DSON-N} is approximately 0.16 Ω. At V_{IN1} = 2.3 V, these values change to 0.31 Ω and 0.21 Ω, respectively, and at V_{IN1} = 5.5 V, the values are 0.16 Ω and 0.14 Ω, respectively.

Switching losses are associated with the current drawn by the driver to turn on and turn off the power devices at the switching frequency. The amount of switching power loss is given by:

$$P_{SW} = (C_{GATE-P} + C_{GATE-N}) \times V_{IN1}{}^2 \times f_{SW} \quad (10)$$

where:
C_{GATE-P} is the PMOSFET gate capacitance.
C_{GATE-N} is the NMOSFET gate capacitance.

For the ADP5040, the total of (C_{GATE-P} + C_{GATE-N}) is approximately 150 pF.

The transition losses occur because the PMOSFET cannot be turned on or off instantaneously, and the SW node takes some time to slew from near ground to near V_{OUT1} (and from V_{OUT1} to ground). The amount of transition loss is calculated by:

$$P_{TRAN} = V_{IN1} \times I_{OUT1} \times (t_{RISE} + t_{FALL}) \times f_{SW} \quad (11)$$

where t_{RISE} and t_{FALL} are the rise time and the fall time of the switching node, SW. For the ADP5040, the rise and fall times of SW are in the order of 5 ns.

If the preceding equations and parameters are used for estimating the converter efficiency, note that the equations do not describe all of the converter losses, and the parameter values given are typical numbers. The converter performance also depends on the choice of passive components and board layout; therefore, a sufficient safety margin should be included in the estimate.

LDO Regulator Power Dissipation

The power loss of a LDO regulator is given by:

$$P_{DLDO} = [(V_{IN} - V_{OUT}) \times I_{LOAD}] + (V_{IN} \times I_{GND}) \quad (12)$$

where:
I_{LOAD} is the load current of the LDO regulator.
V_{IN} and V_{OUT} are input and output voltages of the LDO, respectively.
I_{GND} is the ground current of the LDO regulator.

Power dissipation due to the ground current is small and it can be ignored.

The total power dissipation in the ADP5040 simplifies to:

$$P_D = \{[P_{DBUCK} + P_{DLDO1} + P_{DLDO2}]\} \quad (13)$$

Junction Temperature

In cases where the board temperature, T_A, is known, the thermal resistance parameter, θ_{JA}, can be used to estimate the junction temperature rise. T_J is calculated from T_A and P_D using the formula

$$T_J = T_A + (P_D \times \theta_{JA}) \quad (14)$$

The typical θ_{JA} value for the 20-lead, 4 mm × 4 mm LFCSP is 38°C/W (see Table 6). A very important factor to consider is that θ_{JA} is based on a 4-layer, 4 inch × 3 inch, 2.5 oz copper, as per JEDEC standard, and real applications may use different sizes and layers. To remove heat from the device, it is important to maximize the use of copper. Copper exposed to air dissipates heat better than copper used in the inner layers. The exposed pad (EP) should be connected to the ground plane with several vias as shown in Figure 109.

If the case temperature can be measured, the junction temperature is calculated by

$$T_J = T_C + (P_D \times \theta_{JC}) \quad (15)$$

where:

T_C is the case temperature.
θ_{JC} is the junction-to-case thermal resistance provided in Table 6.

When designing an application for a particular ambient temperature range, calculate the expected ADP5040 power dissipation (P_D) due to the losses of all channels by using Equation 8 to Equation 13. From this power calculation, the junction temperature, T_J, can be estimated using Equation 14.

The reliable operation of the buck regulator and the LDO regulator can be achieved only if the estimated die junction temperature of the ADP5040 (Equation 14) is less than 125°C. Reliability and mean time between failures (MTBF) is highly affected by increasing the junction temperature. Additional information about product reliability can be found in the Analog Devices, Inc., Reliability Handbook, which is available at http://www.analog.com/reliability_handbook.

APPLICATION DIAGRAM

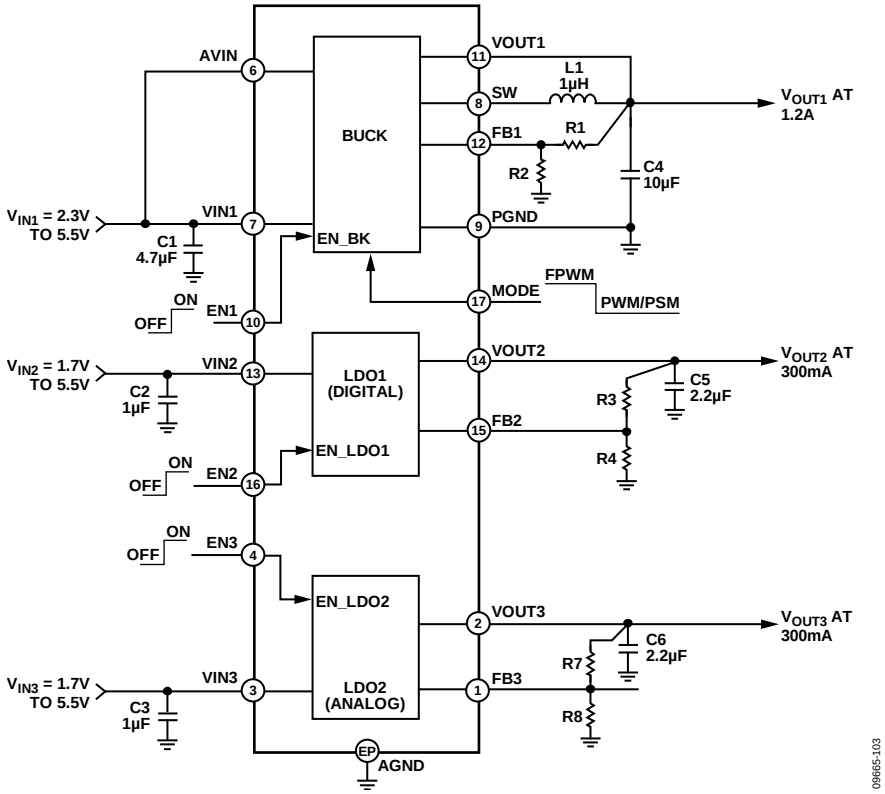


Figure 108. Application Diagram

PCB LAYOUT GUIDELINES

Poor layout can affect ADP5040 performance, causing electromagnetic interference (EMI) and electromagnetic compatibility (EMC) problems, ground bounce, and voltage losses. Poor layout can also affect regulation and stability. A good layout is implemented using the following guidelines:

- Place the inductor, input capacitor, and output capacitor close to the IC using short tracks. These components carry high switching frequencies, and large tracks act as antennas.
- Route the output voltage path away from the inductor and SW node to minimize noise and magnetic interference.
- Maximize the size of ground metal on the component side to help with thermal dissipation.
- Use a ground plane with several vias connecting to the component side ground to further reduce noise interference on sensitive circuit nodes.

SUGGESTED LAYOUT

- See Figure 109 for an example layout.

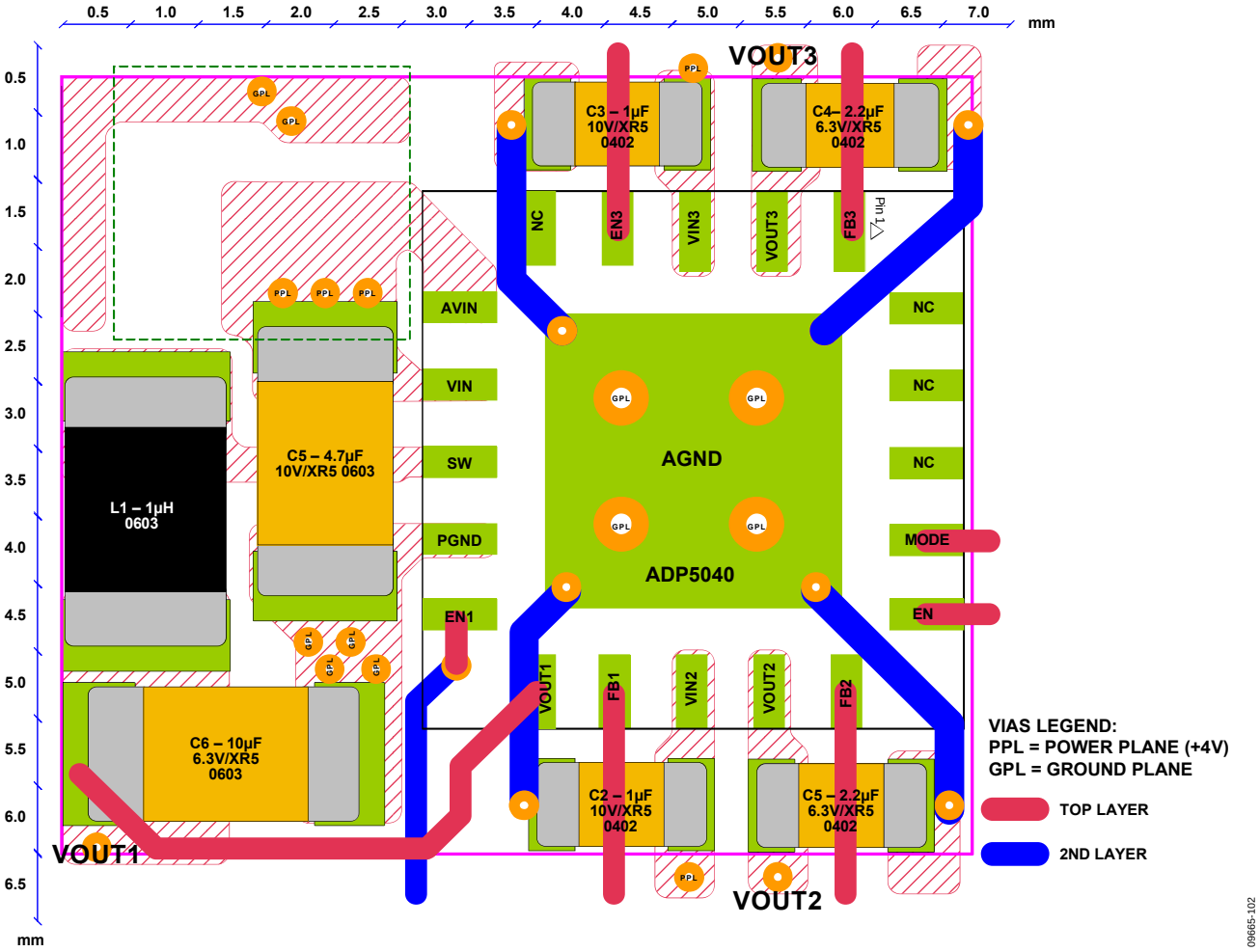


Figure 109. Evaluation Board Layout

BILL OF MATERIALS

Table 13.

Reference	Value	Part Number	Vendor	Package
C1	4.7 µF, X5R, 6.3 V	JMK107BJ475	Taiyo-Yuden	0603
C2, C3	1 µF, X5R, 6.3 V	LMK105BJ105MV-F	Taiyo-Yuden	0402
C4	10 µF, X5R, 6.3 V	JMK107BJ106MA-T	Taiyo-Yuden	0603
C5, C6	2.2 µF, X5R, 6.3 V	JMK105BJ225MV-F	Taiyo-Yuden	0402
L1	1 µH, 85 mΩ, 1400 mA	LQM2MPN1R0NG0B	Murata	2.0 × 1.6 × 0.9 (mm)
	1 µH, 85 mΩ, 1350 mA	MDT2520-CN	Toko	2.5 × 2.0 × 1.2 (mm)
	1 µH, 89 mΩ, 1800 mA	XPL2010-1102ML	Coilcraft	1.9 × 2.0 × 1.0 (mm)
IC1	3-regulator micro PMU	ADP5040	Analog Devices	20-Lead LFCSP

FACTORY PROGRAMMABLE OPTIONS

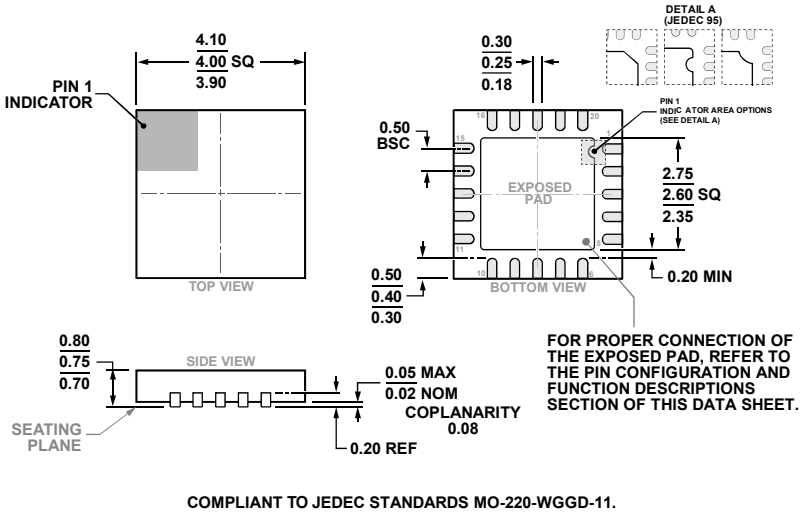
Table 14. Regulator Output Discharge Resistor Options

Selection	Description
0	All discharge resistors disabled
1	All discharge resistors enabled

Table 15. Under Voltage Lockout Options

Selection	Min	Typ	Max	Unit
0	1.95	2.15	2.275	V
1	3.10	3.65	3.90	V

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WGGD-11.

Figure 110. 20-Lead Lead Frame Chip Scale Package [LFCSP]
4 mm × 4 mm Body and 0.75 mm Package Height
(CP-20-8)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	UVLO	Active Pull-Down	Temperature Range	Package Description	Package Option
ADP5040ACPZ-1-R7	2.15 V	Enabled on all channels	T_J = −40°C to +125°C	20-Lead LFCSP	CP-20-8
ADP5040CP-1-EVALZ				Evaluation Board	

[1] Z = RoHS Compliant Part.

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